1 Features

- 10-MHz to 20-GHz output frequency
- –110 dBc/Hz phase noise at 100-kHz offset with 15-GHz carrier
- 45-fs rms jitter at 7.5 GHz (100 Hz to 100 MHz)
- Programmable output power
- PLL key specifications
  - Figure of merit: –236 dBc/Hz
  - Normalized 1/f noise: –129 dBc/Hz
  - High phase detector frequency
    - 400-MHz integer mode
    - 300-MHz fractional mode
    - 32-bit fractional-N divider
- Remove integer boundary spurs with programmable input multiplier
- Synchronization of output phase across multiple devices
- Support for SYSREF with 9-ps resolution programmable delay
- Frequency ramp and chirp generation ability for FMCW applications
- < 20-μs VCO calibration speed
- 3.3-V single power supply operation

2 Applications

- 5G and mm-Wave wireless infrastructure
- Test and measurement equipment
- Radar
- MIMO
- Phased array antennas and beam forming
- High-speed data converter clocking (supports JESD204B)

3 Description

The LMX2595 high-performance, wideband synthesizer that can generate any frequency from 10 MHz to 20 GHz. An integrated doubler is used for frequencies above 15 GHz. The high-performance PLL with figure of merit of –236 dBc/Hz and high-phase detector frequency can attain very low in-band noise and integrated jitter. The high-speed N-divider has no pre-divider, thus significantly reducing the amplitude and number of spurs. There is also a programmable input multiplier to mitigate integer boundary spurs.

The LMX2595 allows users to synchronize the output of multiple devices and also enables applications that need deterministic delay between input and output. A frequency ramp generator can synthesize up to two segments of ramp in an automatic ramp generation option or a manual option for maximum flexibility. The fast calibration algorithm allows changing frequencies faster than 20 μs. The LMX2595 adds support for generating or repeating SYSREF (compliant to JESD204B standard) designed for low-noise clock sources in high-speed data converters. A fine delay adjustment (9-ps resolution) is provided in this configuration to account for delay differences of board traces.

The output drivers within LMX2595 deliver output power as high as 7 dBm at 15-GHz carrier frequency. The device runs from a single 3.3-V supply and has integrated LDOs that eliminate the need for on-board low noise LDOs.

Device Information

<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>PACKAGE</th>
<th>BODY SIZE (NOM)</th>
</tr>
</thead>
<tbody>
<tr>
<td>LMX2595</td>
<td>VQFN (40)</td>
<td>6.00 mm × 6.00 mm</td>
</tr>
</tbody>
</table>

(1) For all available packages, see the orderable addendum at the end of the data sheet.
Changes from Revision B (March 2018) to Revision C

- Changed the maximum output frequency from 19 GHz to 20 GHz everywhere in the data sheet. The newly recommended value for the DBLR_IBIAS_CTRL1 (R25[15:0]) extended the output frequency range and improved high frequency performance. The old value (1572) for the DBLR_IBIAS_CTRL1 still supports up to 19-GHz output and specs characterized in the Electrical Characteristics table. The new value (3115) provides a bonus in performance. .................................................. 1
- Deleted the recommended bypass capacitor values for Vcc pins 7, 11, 15, 21, 26 and 37, as these capacitor values are not mandatory and the power supply filtering design is up to the user. ........................................................................................................... 7
- Added test condition "DBLR_IBIAS_CTRL1 = 1572" for P.OUT, VCCD, and H1/2, in order to emphasize that these data are taken while DBLR_IBIAS_CTRL1 is set to the old value (1572). With this register set to 3115, these specs can be improved. The details can be found in the applications section. ........................................................................................................................................... 9
- Added a new row for VCO doubler output range in EC table with DBLR_IBIAS_CTRL1 set to 3115. The frequency range is extended to 20 GHz. .................................................................................................................................................. 9
- Added table note for EC table stating that the performance of 1/2 harmonic, output power and noise floor with doubler enabled can be improved by setting DBLR_IBIAS_CTRL1 = 3115. ........................................................................................................................................... 9
- Changed all the ‘FRAC_ORDER’ to ‘MASH_ORDER’ to avoid confusion .......................................................................................................................................................................................................................................................... 10
- Changed the names of timing specs to align with timing diagram: changed tCE to tES, tCS to tDCS, tCH to tCDH, and tCES to tECS .......................................................................................................................................................................................... 12
- Changed the names of timing specs to align with timing diagram: changed tES to tCE, tCES to tECS, added tDCS and tCDH, and changed tCS to tCR ........................................................................................................................................................................................................................................... 13
- Changed the serial data input timing diagram and corrected the typo for ‘SCK’. ........................................................................................................................................................................................................................................... 13
- Deleted the note ‘The CSB transition from high to low must occur when SCK is low’ from the serial data input timing diagram, because SPI mode 4 (CPOL = 1, CPHA = 1) is also supported, and SCK is held high when idle in mode 2 .......................................................................................................................................................................................... 13
- Added note for the serial data input timing diagram to explain the tCE requirement for mode 4 (CPOL = 1, CPHA = 1) of SPI, because the diagram only indicated SPI mode 1 (CPOL = 0, CPHA = 0) ........................................................................................................................................................................................................................................................................................................................................................................... 13
- Changed the serial data readback timing diagram ........................................................................................................................................................................................................................................................................................................... 14
- Changed the note about MUXout clocking out and emphasized the effect of tCR on the readback data available time ........................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................... 14
- Added phase noise plot for 16-, 17- and 20-GHz frequency output ........................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................................... 15
- Changed the phase noise plot for 18- and 19-GHz frequency output after changing DBLR_IBIAS_CTRL1.
### Revision History (continued)

- Added the `Bias Levels of Pins` table ................................................................. 67
- Added recommended value for register `CAL_CLK_DIV` when lock time is not of concern ......................................................... 48
- Changed the `VCO_DACISET` in the register map. Bit 0 of this register was not included in the map. The full register map and register description were correct ......................................................... 50
- Added description to the `R4[15:8]`: `ACAL_CMP_DLY` register .......................... 50
- Deleted the bit description '0: disabled; 1: enabled' for register 'PLL_N' .......... 51
- Added description to the `R60[15:0]` `LD_DLY` register ........................................... 53
- Added description for register `R25[15:0]` to the new value ............................. 15
- Changed the `fOUT` test conditions in the `Closed-Loop Phase Noise at 3.5 GHz` graph from: 14 GHz / 2 = 3.5 GHz to: 14 GHz / 4 = 3.5 GHz .............................................................. 16
- Changed the `Output Power vs Pull-up` graph. Output power below 15GHz is shown in "output power across frequency"; output power above 15GHz is shown in "output power vs temperature with doubler". .................................................. 16
- Split the `Output Power vs Temperature` typical performance plot into two plots: `Output Power vs Temperature Without Doubler`, which goes up to 15 GHz, and `Output Power vs Temperature With Doubler` that is between 15 GHz and 21 GHz. The data for "without doubler" is unchanged because change of `DBLR_IBIAS_CTRL1` does not impact performance under 15 GHz, while the data for "with doubler" plot is taken with `DBLR_IBIAS_CTRL1` (`R25[15:0]`) set to the new value (3115) ............................................................................ 17
- Added `Normalized Output Power Across OUTA_PWR With Resistor Pullup` graph ......................................................................................................................... 17
- Changed "Vtune" to "Indirect Vtune" when LD_TYPE = 1 ........................................ 23
- Changed description for LD_TYPE ....................................................................... 23
- Added description of Indirect Vtune. ................................................................. 24
- Added description for the 'no assist' mode, emphasized the effect of `VCO_SEL`, `VCO_DACISET_STRT` and `VCO_CAPCTRL_STRT` under 'no assist' mode, and added recommended values for these registers ................................................................. 25
- Added description for the 'full assist' mode to allow the user to set VCO amplitude and capcode using linear interpolation under certain conditions ................................................................................. 25
- Changed `OUTx_PWR Recommendations for Resistor Pullup` table ....................... 27
- Added description for category 3 of SYNC feature stating that FCAL_EN needs to be 1 ................................................................. 31
- Changed description of MASH_SEED ................................................................... 31
- Added 10-ms wait time before re-programming register `R0` in recommended initial power-up sequence ................................................................. 42
- Added the `General Programming Requirements` section based on frequently asked questions ................................................................. 42
- Changed register `R4` in the register map to: exposed `ACAL_CMP_DLY` ................. 43
- Changed the register `R20[14]` value from 0 to 1 in the full register map to match the `R20` register description ................................................................. 43
- Changed register `R25` in the register map; exposed the register `DBLR_IBIAS_CTRL1` .......................................................................................................................... 44
- Changed the `R0[14]` register field name in the register map from `VCO_PHASE_SYNC_EN` to `VCO_PHASE_SYNC`. to align with the rest of the data sheet ............................................................................................................. 48
- Added recommended value for register `CAL_CLK_DIV` when lock time is not of concern ......................... 48
- Changed the `out32` mode for register 'VCO_DACISET' in the register map. Bit 0 of this register was not included in the map. The full register map and register description were correct ......................................................... 50
- Added description to the `R4[15:8]`: `ACAL_CMP_DLY` register .......................... 50
- Deleted the bit description '0: disabled; 1: enabled' for register 'PLL_N' .......... 51
- Added description to the `R60[15:0]` `LD_DLY` register ........................................... 53
- Added description for register `R25[15:0]`: `DBLR_IBIAS_CTRL1` and changed the default register value from 0x0624 to 0x0C2B ................................................................. 55
- Changed the `R31[14]` register name from `CHDIV_DIV2` to `SEG1_EN` to align with the naming in the TICS Pro GUI ............................. 55
- Changed the `R10S[1:0]` field name from `RAMP_NEXT_TRIG` to `RAMP1.Next_TRIG` ................................................................. 60
- Added application section "Performance Comparison Between 1572 (0x0624) and 3115 (0x0C2B) For Register `DBLR_IBIAS_CTRL1` (R25[15:0])" to compare the performance with old and new `DBLR_IBIAS_CTRL1` (R25[15:0]) values. ............................................................................................................. 62
- Added the `Bias Levels of Pins` table ................................................................. 67

### Changes from Revision A (August 2017) to Revision B

<table>
<thead>
<tr>
<th>Change</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>Changed all the VCO Gain typical values in the <code>Electrical Characteristics</code> table. This is due to improved measurement methods and NOT a change in the device itself</td>
<td>12</td>
</tr>
<tr>
<td>Moved the high-level output voltage parameter <code>Vcc</code> – 0.4 value from the MAX column to the MIN</td>
<td>12</td>
</tr>
<tr>
<td>Moved the high-level output current parameter 0.4 value from the MIN column to the MAX</td>
<td>12</td>
</tr>
</tbody>
</table>
• Changed bulleted text: data is clocked out on MUXOut, not SDI pin .......................................................... 14
• Added comment that OSCin is clocked on rising edges of the signal. and reformatted with bulleted list .......... 21
• Added description of the state machine clock ......................................................................................... 22
• Changed example from: 200 MHz / 232 to: 200 MHz / (232 − 1) .......................................................... 23
• Changed LD_DLY description in Table 4 and removed duplicated text in the Lock Detect section .......... 23
• Changed name from VCO_AMPCAL to VCO_DACISET_STRT ........................................................... 25
• Added more programmable settings to Table 5 ..................................................................................... 25
• Changed VCO Gain table ...................................................................................................................... 26
• Added OUTx_PWR states 32 to 47 are redundant and reworded section .............................................. 27
• Added term "IncludedDivide" for clarity ................................................................................................. 28
• Changed Fixed Diagram to show SEG0, SEG1, SEG2, and SEG3 ......................................................... 29
• Changed included channel divide to IncludedDivide and 2 X SEG0 to 2 X SEG1. Also clarified IncludedDivide calculations ................................................................. 31
• Added more description on conditions for phase adjust .................................................................... 31
• Changed text from: (VCO_PHASE_SYNC = 1) to: (VCO_PHASE_SYNC = 0) ........................................ 31
• Changed text so the user does not incorrectly assume that MASH_SEED varies from part to part .......... 32
• Changed the RAMP_THRESH programming from: 0 to ± 232 to: 0 to ± 233 − 1 .................................. 32
• Removed comment that RAMP_TRIG_CAL only applies in automatic ramping mode ......................... 32
• Changed the RAMP_LOW and _HIGH programming from: 0 to ± 231 to: 0 to ± 233 − 1 ................. 32
• Changed description to be in terms of state machine cycles ............................................................... 33
• Changed RAMP_MODE to RAMP_MANUAL in the Manual Pin Ramping and Automatic Ramping sections ................................................................. 33
• Added that the RampCLK pin input is reclocked to the phase detector frequency .............................. 33
• Added that RampDir rising edges should be targeted away from rising edges of RampCLK pin........ 33
• Changed programming enumerations for RAMP0_INC and RAMP1_INC ........................................ 35
• Changed programming enumerations for RAMP_THRESH, RAMPx_LEN, and RAMP1_INC .............. 36
• Changed Figure 35 ............................................................................................................................. 36
• Changed SysRef description ................................................................................................................. 37
• Added divide by 2 to figure .................................................................................................................. 37
• Changed some entries in the table ...................................................................................................... 37
• Changed fINTERPOLATOR SYSREF setup equation in Table 19 ...................................................... 37
• Changed SysRef delay from: 224 and 225 to: 225 and 226 ............................................................... 38
• Changed “generator” mode to “master” mode. They mean the same thing ........................................ 38
• Changed description for SYSREF_DIV ............................................................................................. 38
• Changed Figure 37 ............................................................................................................................. 39
• Changed wording for repeater mode and master mode ..................................................................... 40
• Changed description of a few of the steps .......................................................................................... 41
• Changed typo in R17 and R19 ............................................................................................................ 50
• Deleted reference to VCO_SEL_STRT_EN. This is always 1 .............................................................. 50
• Added VCO_SEL_STRT_EN reference. This is always 1 ............................................................... 50
• Changed the enumerations 0-3 and added content to the INPIN_LVL field description .................. 52
• Added Divide by 1 to SYSREF_DIV_PRE register description. Also fixed the name misspelling .... 52
• Deleted redundant formula for Fout and also clarified SYSREF_DIV starts at 4 and counts by 2 ...... 54
• Deleted reference to VCO_CAPCTRL_EN, which is always 1, and clarified ........................................ 56
• Changed text from: fMAX to: fHIGH .................................................................................................. 57
• Changed text from: RAMP_LIMIT_LOW=232 - (fLOW × fVCO) / fPD × 16777216 to: RAMP_LIMIT_LOW=233 - 16777216 x (fVCO - fLOW) / fPD .................................................. 57
• Removed the OSCin Configuration table and added content to the OSCin Configuration section ......... 61
• Changed pin 27 recommendation from 10 µF to 1 µF in Figure 62

Changes from Original (June 2017) to Revision A

- Clarified that output power assumes that load is matched and losses are de-embedded
- Changed “SDA” pin name mispelled. Should be “SDI”. Also fixed in timing diagrams. Also added CE Pin
- Swapped SDI and SCK in diagram
- Added section on fine tune adjustments
- Added INPIN_IGNORE, INPIN_LVL, and INPIN_HYST
- Removed RAMP0_FL from register map
- Clarified MASH_RESET_N. 0 = RESET (integer mode), 1 = Fractional mode
- Changed OUT_ISEL to OUTI_SET
- Added section for input register descriptions
- Fixed TYPO table to match main register map
- Corrected RAMP_BURST_TRIG description to match other place in data sheet
- Removed duplicate error in R101[2]
- Changed RAMP1_INC from RAMP0 to RAMP1
- Clarified that the delay was in state machine cycles
- Fixed pin names in schematic
5 Pin Configuration and Functions
### Pin Functions

<table>
<thead>
<tr>
<th>NO.</th>
<th>NAME</th>
<th>I/O</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>CE</td>
<td>Input</td>
<td>Chip enable input. Active HIGH powers on the device.</td>
</tr>
<tr>
<td>2</td>
<td>GND</td>
<td>Ground</td>
<td>VCO ground.</td>
</tr>
<tr>
<td>3</td>
<td>VbiasVCO</td>
<td>Bypass</td>
<td>VCO bias. Requires a 10-µF capacitor connected to VCO ground. Place close to pin.</td>
</tr>
<tr>
<td>5</td>
<td>SYNC</td>
<td>Input</td>
<td>Phase synchronization pin. Has programmable threshold.</td>
</tr>
<tr>
<td>6</td>
<td>GND</td>
<td>Ground</td>
<td>Digital ground.</td>
</tr>
<tr>
<td>7</td>
<td>VccDIG</td>
<td>Supply</td>
<td>Digital supply. TI recommends bypassing with decoupling capacitor to digital ground.</td>
</tr>
<tr>
<td>8</td>
<td>OSCinP</td>
<td>Input</td>
<td>Reference input clock (+). High-impedance self-biasing pin. Requires AC-coupling capacitor. (0.1 µF recommended)</td>
</tr>
<tr>
<td>9</td>
<td>OSCinM</td>
<td>Input</td>
<td>Reference input clock (–). High impedance self-biasing pin. Requires AC-coupling capacitor. (0.1 µF recommended)</td>
</tr>
<tr>
<td>10</td>
<td>VregIN</td>
<td>Bypass</td>
<td>Input reference path regulator output. Requires a 1-µF capacitor connected to ground. Place close to pin.</td>
</tr>
<tr>
<td>11</td>
<td>VccCP</td>
<td>Supply</td>
<td>Charge pump supply. TI recommends bypassing with decoupling capacitor to charge pump ground.</td>
</tr>
<tr>
<td>12</td>
<td>CPOut</td>
<td>Output</td>
<td>Charge pump output. TI recommends connecting C1 of loop filter close to pin.</td>
</tr>
<tr>
<td>13</td>
<td>GND</td>
<td>Ground</td>
<td>Charge pump ground.</td>
</tr>
<tr>
<td>15</td>
<td>VccMASH</td>
<td>Supply</td>
<td>Digital supply. TI recommends bypassing with decoupling capacitor to digital ground.</td>
</tr>
<tr>
<td>16</td>
<td>SCK</td>
<td>Input</td>
<td>SPI clock. High impedance CMOS input. 1.8-V to 3.3-V logic.</td>
</tr>
<tr>
<td>17</td>
<td>SDI</td>
<td>Input</td>
<td>SPI data. High impedance CMOS input. 1.8-V to 3.3-V logic.</td>
</tr>
<tr>
<td>18</td>
<td>RFoutBM</td>
<td>Output</td>
<td>Differential output B (–). Requires a pullup (typically 50-Ω resistor) connected to Vcc as close to the pin as possible. Can be used as an output signal or SYSREF output.</td>
</tr>
<tr>
<td>19</td>
<td>RFoutBP</td>
<td>Output</td>
<td>Differential output B (+). Requires a pullup (typically 50-Ω resistor) connected to Vcc as close to the pin as possible. Can be used as an output signal or SYSREF output.</td>
</tr>
<tr>
<td>20</td>
<td>MUXOut</td>
<td>Output</td>
<td>Multiplexed output pin — lock detect, readback, diagnostics, ramp status.</td>
</tr>
<tr>
<td>21</td>
<td>VccBUF</td>
<td>Supply</td>
<td>Output buffer supply. TI recommends bypassing with decoupling capacitor to RFout ground.</td>
</tr>
<tr>
<td>22</td>
<td>RFoutAM</td>
<td>Output</td>
<td>Differential output A (–). Requires connecting a 50-Ω resistor pullup to Vcc as close to the pin as possible.</td>
</tr>
<tr>
<td>23</td>
<td>RFoutAP</td>
<td>Output</td>
<td>Differential output A (+). Requires connecting a 50-Ω resistor pullup to Vcc as close to the pin as possible.</td>
</tr>
<tr>
<td>24</td>
<td>CSB</td>
<td>Input</td>
<td>SPI latch. Chip Select Bar. High-impedance CMOS input. 1.8-V to 3.3-V logic.</td>
</tr>
<tr>
<td>26</td>
<td>VccVCO2</td>
<td>Supply</td>
<td>VCO supply. TI recommends bypassing with decoupling capacitor to VCO ground.</td>
</tr>
<tr>
<td>27</td>
<td>VbiasVCO2</td>
<td>Bypass</td>
<td>VCO bias. Requires a 1-µF capacitor connected to VCO ground.</td>
</tr>
<tr>
<td>28</td>
<td>SysRefReq</td>
<td>Input</td>
<td>SYSREF request input for JESD204B support.</td>
</tr>
<tr>
<td>29</td>
<td>VrefVCO2</td>
<td>Bypass</td>
<td>VCO supply reference. Requires a 10-µF capacitor connected to VCO ground.</td>
</tr>
<tr>
<td>30</td>
<td>RampClk</td>
<td>Input</td>
<td>Input pin for ramping mode that can be used to clock the ramp in manual ramping mode or as a trigger input.</td>
</tr>
<tr>
<td>32</td>
<td>RampDir</td>
<td>Input</td>
<td>Input pin for ramping mode that can be used to change ramp direction in manual ramping mode or as a trigger input.</td>
</tr>
<tr>
<td>33</td>
<td>VbiasVARAC</td>
<td>Bypass</td>
<td>VCO Varactor bias. Requires a 10-µF capacitor connected to VCO ground.</td>
</tr>
<tr>
<td>35</td>
<td>Vtune</td>
<td>Input</td>
<td>VCO tuning voltage input.</td>
</tr>
<tr>
<td>36</td>
<td>VrefVCO</td>
<td>Bypass</td>
<td>VCO supply reference. Requires a 10-µF capacitor connected to VCO ground.</td>
</tr>
<tr>
<td>37</td>
<td>VccVCO</td>
<td>Supply</td>
<td>VCO supply. Recommend bypassing with decoupling capacitor to ground.</td>
</tr>
<tr>
<td>38</td>
<td>VregVCO</td>
<td>Bypass</td>
<td>VCO regulator node. Requires a 1-µF capacitor connected to ground.</td>
</tr>
<tr>
<td>DAP</td>
<td>GND</td>
<td>Ground</td>
<td>Die Attached Pad. Used for RFout ground.</td>
</tr>
</tbody>
</table>
6 Specifications

6.1 Absolute Maximum Ratings
over operating free-air temperature range (unless otherwise noted)\(^{1}\)

<table>
<thead>
<tr>
<th></th>
<th>MIN</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>(V_{CC})</td>
<td>–0.3</td>
<td>3.6</td>
<td>V</td>
</tr>
<tr>
<td>(T_J)</td>
<td>–40</td>
<td>150</td>
<td>°C</td>
</tr>
<tr>
<td>(T_{stg})</td>
<td>–65</td>
<td>150</td>
<td>°C</td>
</tr>
</tbody>
</table>

\(^{1}\) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

<table>
<thead>
<tr>
<th></th>
<th>VALUE</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>(V_{(ESD)})</td>
<td>±2000</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>±750</td>
<td>V</td>
</tr>
</tbody>
</table>

\(^{1}\) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500 V HBM is possible with the necessary precautions. Pins listed as ±XXX V may actually have higher performance.

\(^{2}\) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250 V CDM is possible with the necessary precautions. Pins listed as ±YYY V may actually have higher performance.

6.3 Recommended Operating Conditions
over operating free-air temperature range (unless otherwise noted)

<table>
<thead>
<tr>
<th></th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>(V_{CC})</td>
<td>3.15</td>
<td>3.3</td>
<td>3.45</td>
<td>V</td>
</tr>
<tr>
<td>(T_A)</td>
<td>–40</td>
<td>25</td>
<td>85</td>
<td>°C</td>
</tr>
<tr>
<td>(T_J)</td>
<td></td>
<td></td>
<td>125</td>
<td>°C</td>
</tr>
</tbody>
</table>

6.4 Thermal Information

<table>
<thead>
<tr>
<th>THERMAL METRIC(^{1})</th>
<th>LMX2595</th>
</tr>
</thead>
<tbody>
<tr>
<td>(R_{th JA})</td>
<td>RHA (VQFN)</td>
</tr>
<tr>
<td>(R_{th JC(top)})</td>
<td>30.5</td>
</tr>
<tr>
<td>(R_{th JB})</td>
<td>15.3</td>
</tr>
<tr>
<td>(\psi_{JT})</td>
<td>5.4</td>
</tr>
<tr>
<td>(\psi_{JB})</td>
<td>0.2</td>
</tr>
<tr>
<td>(R_{th JC(bot)})</td>
<td>5.3</td>
</tr>
<tr>
<td>(R_{th JC(bot)})</td>
<td>0.9</td>
</tr>
</tbody>
</table>

\(^{1}\) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report (SPRA953).

\(^{2}\) DAP
## 6.5 Electrical Characteristics

3.15 V ≤ V\text{CC} ≤ 3.45 V. –40°C ≤ T\text{A} ≤ +85°C. Typical values are at V\text{CC} = 3.3 V, 25°C (unless otherwise noted).

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>V\text{CC}</td>
<td>Supply voltage</td>
<td>3.15</td>
<td>3.3</td>
<td>3.45</td>
<td>V</td>
</tr>
<tr>
<td>I\text{CC}</td>
<td>Supply current</td>
<td>OUTA_PD = 0, OUTB_PD = 1&lt;br&gt;OUTA_MUX = OUTB_MUX = 1&lt;br&gt;OUTA_PWR = 31, CPG=7&lt;br&gt;\text{f}<em>{\text{OSC}} = \text{f}</em>{\text{PD}} = 100 MHz, \text{f}<em>{\text{VCO}} = \text{f}</em>{\text{OUT}} = 14 GHz&lt;br&gt;\text{P}_{\text{OUT}} = 3 \text{ dBm with 50-Ω resistor pullup}</td>
<td>340</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Power-on reset current</td>
<td>RESET=1</td>
<td>170</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Power-down current</td>
<td>POWERDOWN=1</td>
<td>5</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

### OUTPUT CHARACTERISTICS

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>P\text{OUT}</td>
<td>Single-ended output power(^{(1),(2)})</td>
<td>50-Ω resistor pullup&lt;br&gt;OUTx_PWR = 50&lt;br&gt;\text{f}_{\text{OUT}} = 8 GHz</td>
<td>5</td>
<td>dBm</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1-nH inductor pullup&lt;br&gt;OUTx_PWR = 50&lt;br&gt;\text{f}_{\text{OUT}} = 8 GHz</td>
<td>10</td>
<td>dBm</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Single-ended output power with doubler enabled(^{(5)})</td>
<td>50-Ω resistor pullup&lt;br&gt;OUTx_PWR = 50&lt;br&gt;VCO_2X_EN = 1&lt;br&gt;DBLR_IBIAS_CTRL1 = 1572&lt;br&gt;\text{f}_{\text{OUT}} = 15 GHz</td>
<td>0</td>
<td>dBm</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1-nH inductor pullup&lt;br&gt;OUTx_PWR = 50&lt;br&gt;VCO_2X_EN = 1&lt;br&gt;DBLR_IBIAS_CTRL1 = 1572&lt;br&gt;\text{f}_{\text{OUT}} = 15 GHz</td>
<td>–4</td>
<td>dBm</td>
<td></td>
<td></td>
</tr>
<tr>
<td>f\text{VCO_2X}</td>
<td>VCO doubler output range</td>
<td>VCO doubler enabled&lt;br&gt;DBLR_IBIAS_CTRL1 = 1572&lt;br&gt;\text{f}_{\text{OUT}} = 18 GHz</td>
<td>15</td>
<td>19</td>
<td>GHz</td>
</tr>
<tr>
<td></td>
<td>DBLR_IBIAS_CTRL1 = 3115&lt;br&gt;\text{f}_{\text{OUT}} = 20 GHz</td>
<td>15</td>
<td>20</td>
<td>GHz</td>
<td></td>
</tr>
<tr>
<td>Lf\text{VCO_2X}</td>
<td>VCO doubler noise floor(^{(3)})</td>
<td>50-Ω resistor pullup&lt;br&gt;OUTx_PWR = 50&lt;br&gt;DBLR_IBIAS_CTRL1 = 1572&lt;br&gt;\text{f}_{\text{OUT}} = 18 GHz</td>
<td>–148</td>
<td>dBc/Hz</td>
<td></td>
</tr>
<tr>
<td>Xtalk</td>
<td>Isolation between outputs A and B. Measured on output A</td>
<td>OUTA_MUX = VCO&lt;br&gt;OUTB_MUX = channel divider</td>
<td>–50</td>
<td>dBc</td>
<td></td>
</tr>
<tr>
<td>H\text{1/2}</td>
<td>1/2 harmonic spur(^{(3)})</td>
<td>OUTA_MUX=VCO2X&lt;br&gt;\text{f}_{\text{VCO}} = 9 GHz&lt;br&gt;DBLR_IBIAS_CTRL1 = 1572</td>
<td>–10</td>
<td>dBc</td>
<td></td>
</tr>
<tr>
<td>H2</td>
<td>Second harmonic(^{(2)})</td>
<td>OUTA_MUX = VCO&lt;br&gt;\text{f}_{\text{VCO}} = 8 GHz</td>
<td>–20</td>
<td>dBc</td>
<td></td>
</tr>
<tr>
<td></td>
<td>OUTA_MUX = VCO&lt;br&gt;\text{f}_{\text{VCO}} = 11 GHz</td>
<td>–30</td>
<td>dBc</td>
<td></td>
<td></td>
</tr>
<tr>
<td>H3</td>
<td>Third harmonic(^{(2)})</td>
<td>OUTA_MUX = VCO&lt;br&gt;\text{f}_{\text{VCO}} = 8 GHz</td>
<td>–50</td>
<td>dBc</td>
<td></td>
</tr>
</tbody>
</table>

### INPUT SIGNAL PATH

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>f\text{OSC}</td>
<td>Reference input frequency</td>
<td>OSC_2X = 0</td>
<td>5</td>
<td>1400</td>
<td>MHz</td>
</tr>
<tr>
<td></td>
<td>OSC_2X = 1</td>
<td>5</td>
<td>200</td>
<td></td>
<td></td>
</tr>
<tr>
<td>V\text{OSC}</td>
<td>Reference input voltage</td>
<td>AC-coupled required(^{(4)})</td>
<td>0.2</td>
<td>2</td>
<td>Vpp</td>
</tr>
</tbody>
</table>

---

(1) Single ended output power obtained after de-embedding microstrip trace losses and matching with a manual tuner. Unused port terminated to 50 ohm load.

(2) Output power, spur, and harmonics can vary based on board layout and components.

(3) 1/2 harmonic, output power and noise floor with doubler enabled are specified in EC table with DBLR\_IBIAS\_CTRL1 = 1572. However, these specs can be improved by setting DBLR\_IBIAS\_CTRL1 = 3115. See Performance Comparison Between 1572 (0x0624) and 3115 (0x0C2B) for Register DBLR\_IBIAS\_CTRL1 (R25[15:0]) for more information.

(4) For lower VCO frequencies, the N divider minimum value can limit the phase-detector frequency.
Electrical Characteristics (continued)

3.15 V ≤ \( V_{CC} \) ≤ 3.45 V, –40°C ≤ \( T_A \) ≤ +85°C. Typical values are at \( V_{CC} = 3.3 \) V, 25°C (unless otherwise noted).

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>( f_{MULT} )</td>
<td>Multiplier frequency (only applies when multiplier is enabled)</td>
<td>Input range</td>
<td>30</td>
<td>70</td>
<td>MHz</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Output range</td>
<td>180</td>
<td>250</td>
<td>MHz</td>
</tr>
<tr>
<td>( f_{PD} )</td>
<td>Phase detector frequency(^{(4)})</td>
<td>Integer mode</td>
<td>MASH_ORDER = 0</td>
<td>0.125</td>
<td>400</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Fractional mode</td>
<td>MASH_ORDER = 1, 2, 3</td>
<td>5</td>
<td>300</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( MASH_ORDER = 4 )</td>
<td>5</td>
<td>240</td>
<td>MHz</td>
</tr>
<tr>
<td>( I_{CPout} )</td>
<td>Charge-pump leakage current</td>
<td>CPG = 0</td>
<td>15</td>
<td>nA</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Effective charge pump current. This is the sum of the up and down currents</td>
<td>CPG = 1</td>
<td>6</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>CPG = 4</td>
<td>3</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>CPG = 5</td>
<td>9</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>CPG = 3</td>
<td>12</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>CPG = 7</td>
<td>15</td>
<td>mA</td>
</tr>
<tr>
<td>( P_{PLL_1/f} )</td>
<td>Normalized PLL 1/f noise</td>
<td>( f_{PD} = 100 ) MHz, ( f_{VCO} = 12 ) GHz(^{(5)})(5)(5)(5)</td>
<td>−129</td>
<td>dBc/Hz</td>
<td></td>
</tr>
<tr>
<td>( P_{PLL_flat} )</td>
<td>Normalized PLL noise floor</td>
<td>( 10^{10} \times PLL_FOM \times \log\left(\frac{f_{PD}}{1\text{Hz}}\right) + 10 \times \log\left(\frac{f_{VCO}}{1\text{GHz}}\right) + 10 \times \log\left(\frac{I_{PD}}{10\text{Hz}}\right) + \log\left(\frac{I_{CPout}}{10\text{mA}}\right) )</td>
<td>−236</td>
<td>dBc/Hz</td>
<td></td>
</tr>
</tbody>
</table>

\(^{(4)}\) The PLL noise contribution is measured using a clean reference and a wide loop bandwidth and is composed into flicker and flat components. PLL\_flat = PLL\_FOM + 20 × \log(Fvco/Fpd) + 10 × \log(Fpd / 1Hz). PLL\_flicker (offset) = PLL\_flicker\_Norm + 20 × \log(Fvco / 1GHz) – 10 × \log(offset / 10kHz). Once these two components are found, the total PLL noise can be calculated as PLL\_Noise = 10 × \log(10^{PLL\_Flat / 10} + 10^{PLL\_flicker / 10})
### Electrical Characteristics (continued)

3.15 V ≤ V\(_{CC}\) ≤ 3.45 V, –40°C ≤ T\(_{A}\) ≤ +85°C. Typical values are at V\(_{CC}\) = 3.3 V, 25°C (unless otherwise noted).

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>VCO CHARACTERISTICS</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO1 (f_{VCO} = 8) GHz</td>
<td>10 kHz</td>
<td>–80</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>100 kHz</td>
<td>–107</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>1 MHz</td>
<td>–128</td>
<td></td>
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<td></td>
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<tr>
<td></td>
<td>10 MHz</td>
<td>–148</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>90 MHz</td>
<td>–157</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO2 (f_{VCO} = 9.2) GHz</td>
<td>10 kHz</td>
<td>–79</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>100 kHz</td>
<td>–105</td>
<td></td>
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<tr>
<td></td>
<td>1 MHz</td>
<td>–127</td>
<td></td>
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<tr>
<td></td>
<td>10 MHz</td>
<td>–147</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>90 MHz</td>
<td>–157</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO3 (f_{VCO} = 10.3) GHz</td>
<td>10 kHz</td>
<td>–77</td>
<td></td>
<td></td>
<td></td>
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<tr>
<td></td>
<td>100 kHz</td>
<td>–104</td>
<td></td>
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<tr>
<td></td>
<td>1 MHz</td>
<td>–126</td>
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<td></td>
<td>10 MHz</td>
<td>–147</td>
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<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>90 MHz</td>
<td>–157</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO4 (f_{VCO} = 11.3) GHz</td>
<td>10 kHz</td>
<td>–76</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>100 kHz</td>
<td>–103</td>
<td></td>
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<td></td>
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<td></td>
<td>1 MHz</td>
<td>–125</td>
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<tr>
<td></td>
<td>10 MHz</td>
<td>–145</td>
<td></td>
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<td></td>
<td>90 MHz</td>
<td>–158</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO5 (f_{VCO} = 12.5) GHz</td>
<td>10 kHz</td>
<td>–74</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>100 kHz</td>
<td>–100</td>
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<td></td>
</tr>
<tr>
<td></td>
<td>1 MHz</td>
<td>–123</td>
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<td>10 MHz</td>
<td>–144</td>
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<td></td>
<td>90 MHz</td>
<td>–157</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO6 (f_{VCO} = 13.3) GHz</td>
<td>10 kHz</td>
<td>–73</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>100 kHz</td>
<td>–100</td>
<td></td>
<td></td>
<td></td>
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<tr>
<td></td>
<td>1 MHz</td>
<td>–122</td>
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<td></td>
<td>10 MHz</td>
<td>–143</td>
<td></td>
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<td></td>
</tr>
<tr>
<td></td>
<td>90 MHz</td>
<td>–155</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCO7 (f_{VCO} = 14.5) GHz</td>
<td>10 kHz</td>
<td>–73</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>100 kHz</td>
<td>–99</td>
<td></td>
<td></td>
<td></td>
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<td></td>
<td>1 MHz</td>
<td>–121</td>
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<td>10 MHz</td>
<td>–143</td>
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<tr>
<td></td>
<td>90 MHz</td>
<td>–152</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>t(_{VCOCAL})  VCO calibration speed</td>
<td>Switch across the entire frequency band (f_{OSC} = 200) MHz, (f_{PD} = 100) MHz (^{(6)})</td>
<td>No assist</td>
<td>50</td>
<td></td>
<td>µs</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Partial assist</td>
<td>35</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Close frequency</td>
<td>20</td>
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</tr>
<tr>
<td></td>
<td></td>
<td>Full assist</td>
<td>5</td>
<td></td>
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</tr>
</tbody>
</table>

\(^{(6)}\) See Application and Implementation for more details on the different VCO calibration modes.
Electrical Characteristics (continued)

3.15 V ≤ VCC ≤ 3.45 V, –40°C ≤ TA ≤ +85°C. Typical values are at VCC = 3.3 V, 25°C (unless otherwise noted).

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>KVCO</td>
<td>VCO gain</td>
<td>8 GHz</td>
<td>92</td>
<td>91</td>
<td>MHz/V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>9.2 GHz</td>
<td>115</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>10.3 GHz</td>
<td>121</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>11.3 GHz</td>
<td>195</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>12.5 GHz</td>
<td>190</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>13.3 GHz</td>
<td>213</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>14.5 GHz</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>ΔTCL</td>
<td>Allowable temperature drift when VCO is not recalibrated RAMP_EN = 0 or RAMP_MANUAL= 1</td>
<td>125</td>
<td></td>
<td>°C</td>
</tr>
<tr>
<td>H2</td>
<td>VCO second harmonic fVCO = 8 GHz, divider disabled</td>
<td>–20</td>
<td></td>
<td></td>
<td>dBC</td>
</tr>
<tr>
<td>H3</td>
<td>VCO third harmonic fVCO = 8 GHz, divider disabled</td>
<td>–50</td>
<td></td>
<td></td>
<td>dBC</td>
</tr>
<tr>
<td></td>
<td></td>
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</tr>
<tr>
<td></td>
<td>SYNC PIN AND PHASE ALIGNMENT</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>fOSCinSYNC</td>
<td>Maximum usable OSCin with sync pin (Figure 33)</td>
<td>Category 3</td>
<td>0</td>
<td>100</td>
<td>MHz</td>
</tr>
<tr>
<td></td>
<td>Categories1 and 2</td>
<td></td>
<td>0</td>
<td>1400</td>
<td></td>
</tr>
</tbody>
</table>

DIGITAL INTERFACE
Applies to SLK, SDI, CSB, CE, RampDir, RampClk, MUXout, SYNC (CMOS Mode), SysRefReq (CMOS Mode)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>VIH</td>
<td>High-level input voltage</td>
<td>1.4</td>
<td></td>
<td>VCC</td>
<td>V</td>
</tr>
<tr>
<td>VIL</td>
<td>Low-level input voltage</td>
<td>0</td>
<td>0.4</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>IH</td>
<td>High-level input current</td>
<td>–25</td>
<td>25</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>IL</td>
<td>Low-level input current</td>
<td>–25</td>
<td>25</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>VOH</td>
<td>High-level output voltage</td>
<td>MUXout pin</td>
<td>Load current = –10 mA</td>
<td>VCC – 0.4</td>
<td>V</td>
</tr>
<tr>
<td>VOL</td>
<td>Low-level output voltage</td>
<td>Load current = 10 mA</td>
<td>0.4</td>
<td>V</td>
<td></td>
</tr>
</tbody>
</table>

6.6 Timing Requirements
(3.15 V ≤ VCC ≤ 3.45 V, –40°C ≤ TA ≤ +85°C, except as specified. Nominal values are at VCC = 3.3 V, TA = 25°C)

SYNC, SYSRefReq, RampClk, and RampDIR Pins

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>tSETUP</td>
<td>Setup time for pin relative to OSCin rising edge</td>
<td>SYNC pin</td>
<td>2.5</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td>SysRefReq pin</td>
<td>2.5</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>tHOLD</td>
<td>Hold time for SYNC pin relative to OSCin rising edge</td>
<td>SYNC pin</td>
<td>2</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td>SysRefReq pin</td>
<td>2</td>
<td></td>
<td>ns</td>
</tr>
</tbody>
</table>

DIGITAL INTERFACE WRITE SPECIFICATIONS

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>tSPWrite</td>
<td>SPI write speed</td>
<td>tCWL + tCWH &gt; 13.333 ns</td>
<td>75</td>
<td>MHz</td>
<td></td>
</tr>
<tr>
<td>tCE</td>
<td>Clock to enable low time</td>
<td>See Figure 1</td>
<td>5</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>tDCS</td>
<td>Data to clock setup time</td>
<td>2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>tCDH</td>
<td>Clock to data hold time</td>
<td>2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>tCWH</td>
<td>Clock pulse width high</td>
<td>5</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>tCWL</td>
<td>Clock pulse width low</td>
<td>5</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>tECS</td>
<td>Enable to clock setup time</td>
<td>5</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>tEWH</td>
<td>Enable pulse width high</td>
<td>2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

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Timing Requirements (continued)

(3.15 V ≤ V_{CC} ≤ 3.45 V, −40°C ≤ T_A ≤ +85°C, except as specified. Nominal values are at V_{CC} = 3.3 V, T_A = 25°C)

<table>
<thead>
<tr>
<th>Specification</th>
<th>Symbol</th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>SPI readback speed</td>
<td>f_{SPI}Readback</td>
<td></td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Clock to enable low time</td>
<td>t_{CE}</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Data to clock setup time</td>
<td>t_{DCS}</td>
<td>2</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Clock to data hold time</td>
<td>t_{CDH}</td>
<td>2</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Clock falling edge to available readback data wait time.</td>
<td>t_{CR}</td>
<td>0</td>
<td>10</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Clock pulse width high</td>
<td>t_{CWH}</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Clock pulse width low</td>
<td>t_{CWL}</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Enable to clock setup time</td>
<td>t_{ECS}</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Enable pulse width high</td>
<td>t_{EWH}</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
</tbody>
</table>

Figure 1. Serial Data Input Timing Diagram

There are several other considerations for writing on the SPI:

- The R/W bit must be set to 0.
- The data on SDI pin is clocked into a shift register on each rising edge on the SCK pin.
- The CSB must be held low for data to be clocked. Device will ignore clock pulses if CSB is held high.
- When SCK and SDI lines are shared between devices, TI recommends to hold the CSB line high on the device that is not to be clocked.
- Note that $t_{CE}$ is only a valid spec if CPOL (Clock Polarity) = 0 and CPHA (Clock Phase) = 0 is used for SPI protocol. For SPI mode (CPOL = 1 and CPHA = 1), the minimum distance required between the last rising edge of clock and the rising edge of CSB is $t_{CE} + clock\_period/2$. 
There are several other considerations for SPI readback:

- The R/W bit must be set to 1.
- The MUXout pin will always be low for the address portion of the transaction.
- The data on MUXout is clocked out at $t_{CR}$ after the falling edge of SCK. In other words, the readback data will be available at the MUXout pin $t_{CR}$ after the clock falling edge.
- The data portion of the transition on the SDI line is always ignored.
6.7 Typical Characteristics

Figure 3. Closed-Loop Phase Noise at 15 GHz

Figure 4. Closed-Loop Phase Noise at 13 GHz

Figure 5. Closed-Loop Phase Noise at 11 GHz

Figure 6. Closed-Loop Phase Noise at 9 GHz

Figure 7. Closed-Loop Phase Noise at 8 GHz

Figure 8. Closed-Loop Phase Noise at 7.5 GHz
Typical Characteristics (continued)

![Graphs showing phase noise at different frequencies.]

Figure 9. Closed-Loop Phase Noise at 3.5 GHz

Figure 10. Closed-Loop Phase Noise at 16 GHz

Figure 11. Closed-Loop Phase Noise at 17 GHz

Figure 12. Closed-Loop Phase Noise at 18 GHz

Figure 13. Closed-Loop Phase Noise at 19 GHz

Figure 14. Closed-Loop Phase Noise at 20 GHz
Figure 15. VCO Ramping 12-GHz to 12.125-GHz Calibration

CalTime = 33.6 µs = 5.8 µs (Core) + 14 µs (Fcal) + 13.8 µs (Ampcal)

f_{OSC} = 200 MHz, f_{PD} = 100 MHz, f_{VCO} = 7.5 - 14 GHz, CHDIV = 2

Figure 16. VCO Ramping 7.5-GHz to 15-GHz Triangle Wave With VCO Calibration

CalTime = 25.2 µs = 1.3 µs (Core) + 9.1 µs (Fcal) + 14.8 µs (Ampcal)

f_{OSC} = 200 MHz, f_{PD} = 100 MHz, f_{VCO} = 7.5 GHz - 14 GHz, CHDIV = 2

Figure 17. VCO Unassisted Calibration

Figure 18. VCO Calibration With Partial Assist

f_{VCO} = 12 GHz

f_{PD} = 100 MHz

Figure 19. Calculation of PLL Noise Metrics

Figure 20. PLL Phase Noise Variation vs. f_{PD}
Typical Characteristics (continued)

- **f_{VCO} = 8 GHz, Narrow Loop Bandwidth (<100 Hz)**

  ![Figure 21. VCO Phase Noise Over Temperature](image)

  ![Figure 22. CHANGE in 8-GHz VCO Phase Noise Over Temperature](image)

- **Single-Ended Output VCO2X\_EN = 0**

  ![Figure 23. Output Power Across Frequency](image)

  ![Figure 24. Output Power vs Temperature Without Doubler](image)

- **Single-ended output with resistor pullup, OUTx\_PWR = 50.**

  Note that Near 13.3 to 14.3 GHz, output power can be impacted at hot temperature. See the Application Information section for more information.

- **Single-ended output with resistor pullup and DBLR\_IBIAS\_CTRL1 = 3115**

  ![Figure 25. Output Power vs. Temperature With Doubler](image)

  ![Figure 26. Output Power Normalized To Maximum Across OUTA\_PWR With Resistor Pullup](image)
Typical Characteristics (continued)

This noise adds to the scaled VCO Noise when the channel divider is used.

Figure 27. Additive VCO Divider Noise Floor
7 Detailed Description

7.1 Overview

The LMX2595 is a high-performance, wideband frequency synthesizer with integrated VCO and output divider. The VCO operates from 7.5 GHz to 15 GHz, and this can be combined with the output divider to produce any frequency in the range of 10 MHz to 15 GHz. The LMX2595 also features a VCO doubler that can be used to produce frequencies up to 20 GHz. Within the input path, there are two dividers and a multiplier for flexible frequency planning. The multiplier also allows the reduction of spurs by moving the frequencies away from the integer boundary.

The PLL is fractional-N PLL with a programmable delta-sigma modulator up to 4\textsuperscript{th} order. The fractional denominator is a programmable 32-bit long, which can easily provide fine frequency steps below 1-Hz resolution, or be used to do exact fractions like 1/3, 7/1000, and many others. The phase frequency detector goes up to 300 MHz in fractional mode or 400 MHz in integer mode, although minimum N-divider values must also be taken into account.

For applications where deterministic or adjustable phase is desired, the SYNC pin can be used to get the phase relationship between the OSCin and RFout pins deterministic. When this is done, the phase can be adjusted in very fine steps of the VCO period divided by the fractional denominator.

The ultra-fast VCO calibration is designed for applications where the frequency must be swept or abruptly changed. The frequency can be manually programmed, or the device can be set up to do ramps and chirps.

The JESD204B support includes using the RFoutB output to create a differential SYSREF output that can be either a single pulse or a series of pulses that occur at a programmable distance away from the rising edges of the output signal.

The LMX2595 device requires only a single 3.3-V power supply. The internal power supplies are provided by integrated LDOs, eliminating the need for high-performance external LDOs.

The digital logic for the SPI interface and is compatible with voltage levels from 1.8 V to 3.3 V.

Table 1 shows the range of several of the dividers, multipliers, and fractional settings.

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>MIN</th>
<th>MAX</th>
<th>COMMENTS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Outputs enabled</td>
<td>0</td>
<td>2</td>
<td></td>
</tr>
<tr>
<td>OSCin doubler</td>
<td>0 (1X)</td>
<td>1 (2X)</td>
<td>The low noise doubler can be used to increase the phase detector frequency to improve phase noise and avoid spurs. This is in reference to the OSC_2X bit.</td>
</tr>
<tr>
<td>Pre-R divider</td>
<td>1 (bypass)</td>
<td>128</td>
<td>Only use the Pre-R divider if the multiplier is used and the input frequency is too high for the multiplier.</td>
</tr>
<tr>
<td>Multiplier</td>
<td>3</td>
<td>7</td>
<td>This is in reference to the MULT word.</td>
</tr>
<tr>
<td>Post-R divider</td>
<td>1 (bypass)</td>
<td>255</td>
<td>The maximum input frequency for the Post-R divider is 250 MHz. Use the Pre-R divider if necessary.</td>
</tr>
<tr>
<td>N divider</td>
<td>( \geq 28 )</td>
<td>524287</td>
<td>The minimum divide depends on modulator order and VCO frequency. See N-Divider and Fractional Circuitry for more details.</td>
</tr>
<tr>
<td>Fractional numerator/denominator</td>
<td>1 (Integer mode)</td>
<td>(2^{32} - 1 = 4294967295)</td>
<td>The fractional denominator is programmable and can assume any value between 1 and (2^{32} - 1); it is not a fixed denominator.</td>
</tr>
<tr>
<td>Fractional order (MASH_ORDER)</td>
<td>0</td>
<td>4</td>
<td>Order 0 is integer mode and the order can be programmed</td>
</tr>
<tr>
<td>Channel divider</td>
<td>1 (bypass)</td>
<td>768</td>
<td>This is the series of several dividers. Also, be aware that above 10 GHz, the maximum allowable channel divider value is 6.</td>
</tr>
<tr>
<td>Output frequency</td>
<td>10 MHz</td>
<td>20 GHz</td>
<td>This is implied by the VCO frequency, channel divider, and VCO doubler.</td>
</tr>
</tbody>
</table>
7.2 Functional Block Diagram

7.3 Feature Description

7.3.1 Reference Oscillator Input

The OSCin pins are used as a frequency reference input to the device. The input is high impedance and requires AC-coupling caps at the pin. A CMOS clock or XO can drive the single-ended OSCin pins. Differential clock input is also supported, making it easier to interface with high-performance system clock devices such as TI’s LMK series clock devices. As the OSCin signal is used as a clock for the VCO calibration, a proper reference signal must be applied at the OSCin pin at the time of programming FCAL_EN.

7.3.2 Reference Path

The reference path consists of an OSCin doubler (OSC_2X), Pre-R divider, multiplier (MULT) and a Post-R divider.

Figure 28. Reference Path Diagram

The OSCin doubler (OSC_2X) can double up low OSCin frequencies. Pre-R (PLL_R_PRE) and Post-R (PLL_R) dividers both divide frequency down while the multiplier (MULT) multiplies frequency up. The purposes of adding a multiplier is to reduce integer boundary spurs or to increase the phase detector frequency. Use Equation 1 to calculate the phase detector frequency, \( f_{PD} \):

\[
 f_{PD} = f_{OSC} \times \text{OSC}_2 \times \text{MULT} / (\text{PLL}_R\_\text{PRE} \times \text{PLL}_R)
\]

- In the OSCin doubler or input multiplier is used, the OSCin signal should have a 50% duty cycle as both the rising and falling edges are used.
- If neither the OSCin doubler nor the input multiplier are used, only rising edges of the OSCin signal are used and duty cycle is not critical.
- The input multiplier and OSCin doubler should not both be used at the same time.
Feature Description (continued)

7.3.2.1 OSCin Doubler (OSC_2X)

The OSCin doubler allows one to double the input reference frequency up to 400 MHz. This doubler adds minimal noise and is useful for raising the phase detector frequency for better phase noise and also to avoid spurs. When the phase-detector frequency is increased, the flat portion of the PLL phase noise improves.

![Figure 29. Benefit of Using the OSC_2X Doubler at 14 GHz](image)

7.3.2.2 Pre-R Divider (PLL_R_PRE)

The Pre-R divider is useful for reducing the input frequency so that the programmable multiplier (MULT) can be used to help meet the maximum 250-MHz input frequency limitation to the PLL-R divider. Otherwise, it does not have to be used.

7.3.2.3 Programmable Multiplier (MULT)

The MULT is useful for shifting the phase-detector frequency to avoid integer boundary spurs. The multiplier allows a multiplication of 3, 4, 5, 6, or 7. Be aware that unlike the doubler, the programmable multiplier degrades the PLL figure of merit. This only would matter, however, for a clean reference and if the loop bandwidth was wide.

7.3.2.4 Post-R Divider (PLL_R)

The Post-R divider can be used to further divide down the frequency to the phase detector frequency. When it is used (PLL_R > 1), the input frequency to this divider is limited to 250 MHz.

7.3.2.5 State Machine Clock

The state machine clock is a divided down version of the OSCin signal that is used internally in the device. This divide value is 1, 2, 4, or 8, and is determined by CAL_CLK_DIV programming word (described in the Programming section). This state machine clock impacts various features like the lock detect delay, VCO calibration, and ramping. The state machine clock is calculated as $f_{smclk} = \frac{f_{OSC}}{2^{\text{CAL}_\text{CLK}_\text{DIV}}}$.

7.3.3 PLL Phase Detector and Charge Pump

The phase detector compares the outputs of the Post-R divider and N-divider, and generates a correction current corresponding to the phase error until the two signals are aligned in-phase. This charge-pump current is software programmable to many different levels, allowing modification of the closed-loop bandwidth of the PLL. See the Application Information section for more information.
Feature Description (continued)

7.3.4 N-Divider and Fractional Circuitry

The N-divider includes fractional compensation and can achieve any fractional denominator from 1 to \(2^{\frac{32}{2}} - 1\). The integer portion of N is the whole part of the N-divider value, and the fractional portion, \(N_{\text{frac}} = \frac{\text{NUM}}{\text{DEN}}\), is the remaining fraction. In general, the total N-divider value is determined by \(N + \frac{\text{NUM}}{\text{DEN}}\). The N, NUM and DEN are software programmable. The higher the denominator, the finer the resolution step of the output. For example, even when using \(f_{PD} = 200\) MHz, the output can increment in steps of \(200\) MHz / \(2^{\frac{32}{2}} - 1\) = 0.047 Hz. Equation 2 shows the relationship between the phase detector and VCO frequencies. Note that in SYNC mode, there is an extra divider that is not shown in Equation 2.

\[
f_{\text{VCO}} = f_{PD} \times \left( \frac{N + \frac{\text{NUM}}{\text{DEN}}}{2^{\frac{32}{2}} - 1} \right)
\]

(2)

The sigma-delta modulator that controls this fractional division is also programmable from integer mode to fourth order. To make the fractional spurs consistent, the modulator is reset any time that the R0 register is programmed.

The N-divider has minimum value restrictions based on the modulator order and VCO frequency. Furthermore, the PFD_DLY_SEL bit must be programmed in accordance to the Table 2.

<table>
<thead>
<tr>
<th>MASH_ORDER</th>
<th>(f_{\text{VCO}}) (MHz)</th>
<th>MINIMUM N</th>
<th>PFD_DLY_SEL</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>(\leq 12500)</td>
<td>28</td>
<td>1</td>
</tr>
<tr>
<td>1</td>
<td>(&gt; 12500)</td>
<td>32</td>
<td>2</td>
</tr>
<tr>
<td></td>
<td>(\leq 10000)</td>
<td>28</td>
<td>1</td>
</tr>
<tr>
<td></td>
<td>10000-12500</td>
<td>32</td>
<td>2</td>
</tr>
<tr>
<td></td>
<td>(&gt;12250)</td>
<td>36</td>
<td>3</td>
</tr>
<tr>
<td>2</td>
<td>(\leq 10000)</td>
<td>32</td>
<td>2</td>
</tr>
<tr>
<td></td>
<td>(&gt;10000)</td>
<td>36</td>
<td>3</td>
</tr>
<tr>
<td>3</td>
<td>(\leq 10000)</td>
<td>36</td>
<td>3</td>
</tr>
<tr>
<td></td>
<td>(&gt;10000)</td>
<td>40</td>
<td>4</td>
</tr>
<tr>
<td>4</td>
<td>(\leq 10000)</td>
<td>44</td>
<td>5</td>
</tr>
<tr>
<td></td>
<td>(&gt;10000)</td>
<td>48</td>
<td>6</td>
</tr>
</tbody>
</table>

7.3.5 MUXout Pin

The MUXout pin can be used to readback programmable states of the device or for lock detect.

<table>
<thead>
<tr>
<th>MUXOUT_SEL</th>
<th>FUNCTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>Readback</td>
</tr>
<tr>
<td>1</td>
<td>Lock Detect</td>
</tr>
</tbody>
</table>

7.3.5.1 Lock Detect

The MUXout pin can be configured for lock detect done in by reading back the rb_LD_VTUNE field or using the pin as shown in the Table 4.

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>LD_TYPE</td>
<td>0 = VCO Calibration Status \ 1 = Indirect Vtune</td>
<td>Select Lock Detect Type.</td>
</tr>
<tr>
<td>LD_DLY</td>
<td>0 to 65535</td>
<td>Only valid for Vtune lock detect. This is a delay in state machine cycles.</td>
</tr>
<tr>
<td>OUT_MUTE</td>
<td>0 = Disabled \ 1 = Enabled</td>
<td>Turns off outputs when lock detect is low.</td>
</tr>
</tbody>
</table>
VCO calibration status lock detect works by indicating a low signal on the MUXout pin whenever the VCO is calibrating or the LD_DLY counter is running. The delay from the LD_DLY is added to the true VCO calibration time \( t_{VCO_{CAL}} \), so it can be used to account for the analog lock time of the PLL.

Indirect Vtune lock detect is based on internally generated voltage that is related to (but not the same as) the Vtune voltage of the charge pump. It indicates a high signal on MUXout pin or reads back state 2 of rb_LD_VTUNE when the device is locked.

### 7.3.5.2 Readback

The MUXout pin can be configured to read back useful information from the device. Common uses for readback are:

1. Read back registers to ensure that they have been programmed to the correct value.
2. Read back the lock detect status to determine if the PLL is in lock.
3. Read back VCO calibration information so that it can be used to improve the lock time.
4. Read back information to help troubleshoot.

### 7.3.6 VCO (Voltage-Controlled Oscillator)

The LMX2595 includes a fully integrated VCO. The VCO takes the voltage from the loop filter and converts this into a frequency. The VCO frequency is related to the other frequencies is shown in Equation 3:

\[
f_{VCO} = f_{PD} \times N \text{ divider}
\]  

\[(3)\]

#### 7.3.6.1 VCO Calibration

To reduce the VCO tuning gain and therefore improve the VCO phase-noise performance, the VCO frequency range is divided into several different frequency bands. The entire range, 7.5 to 15 GHz, covers an octave that allows the divider to take care of frequencies below the lower bound. This creates the need for frequency calibration to determine the correct frequency band given a desired output frequency. The frequency calibration routine is activated any time that the R0 register is programmed with the FCAL_EN = 1. It is important that a valid OSCin signal must present before VCO calibration begins.

The VCO also has an internal amplitude calibration algorithm to optimize the phase noise which is also activated any time the R0 register is programmed.

The optimum internal settings for this are temperature dependent. If the temperature is allowed to drift too much without being recalibrated, some minor phase noise degradation could result. The maximum allowable drift for continuous lock, \( \Delta T_{CL} \), is stated in the electrical specifications. For this device, a number of 125°C means the device never loses lock if the device is operated under the **Recommended Operating Conditions**.
The LMX2595 allows the user to assist the VCO calibration. In general, there are three kinds of assistance, as shown in Table 5:

### Table 5. Assisting the VCO Calibration Speed

<table>
<thead>
<tr>
<th>ASSISTANCE LEVEL</th>
<th>DESCRIPTION</th>
<th>PROGRAMMABLE SETTINGS</th>
</tr>
</thead>
</table>
| No assist        | User does nothing to improve VCO calibration speed, but the user-specified VCO_SEL, VCO_DACISET_STRT and VCO_CAPCTRL_STRT values do affect the starting point of VCO calibration. For oscillation to start up properly and for VCO to calibrate correctly, TI recommends setting VCO_SEL = 7, VCO_DACISET_STRT = 300 and VCO_CAPCTRL_STRT = 183 for all frequencies except 11.9 GHz - 12.1 GHz. For frequencies within 11.9 ~ 12.1 GHz, user must use VCO_SEL = 4 for proper VCO calibration. | QUICK_RECAL_EN=0  
VCO_SEL_FORCE=0  
VCO_DACISET_FORCE=0  
VCO_CAPCTRL_FORCE=0 |
| Partial assist   | Upon every frequency change, before the FCAL_EN bit is checked, the user provides the initial starting point for the VCO core (VCO_SEL), band (VCO_CAPCTRL_STRT), and amplitude (VCO_DACISET_STRT) based on Table 6. | QUICK_RECAL_EN=0  
VCO_SEL_FORCE=0  
VCO_DACISET_FORCE=0  
VCO_CAPCTRL_FORCE=0 |
| Close Frequency Assist | Upon initialization of the device, user enables QUICK_RECAL_EN bit. The VCO uses the current VCO_CAPCTRL and VCO_DACISET_STRT settings as the initial starting point. | QUICK_RECAL_EN=1  
VCO_SEL_FORCE=0  
VCO_DACISET_FORCE=0  
VCO_CAPCTRL_FORCE=0 |
| Full assist      | The user forces the VCO core (VCO_SEL), amplitude settings (VCO_DACISET), and frequency band (VCO_CAPCTRL) and manually sets the value. If the two frequency points are no more than 5MHz apart and on the same VCO core, the user can set the VCO amplitude and capcode for any frequency between those two points using linear interpolation. | QUICK_RECAL_EN=0  
VCO_SEL_FORCE=1  
VCO_DACISET_FORCE=1  
VCO_CAPCTRL_FORCE=1 |

To do the partial assist for the VCO calibration, follow this procedure:

1. **Determine the VCO Core**
   - Find a VCO Core that includes the desired VCO frequency. If at the boundary of two cores, choose one based on phase noise or performance.

2. **Calculate the VCO CapCode as follows**:
   \[ VCO\_CAPCTRL\_STRT = \text{round} \left( C_{\text{CoreMin}} - (C_{\text{CoreMin}} - C_{\text{CoreMax}}) \times \frac{(f_{\text{VCO}} - f_{\text{CoreMin}})}{(f_{\text{CoreMax}} - f_{\text{CoreMin}})} \right) \]

3. **Get the VCO amplitude setting from Table 6.**
   \[ VCO\_DACISET\_STRT = \text{round} \left( A_{\text{CoreMin}} + (A_{\text{CoreMax}} - A_{\text{CoreMin}}) \times \frac{(f_{\text{VCO}} - f_{\text{CoreMin}})}{(f_{\text{CoreMax}} - f_{\text{CoreMin}})} \right) \]

### Table 6. VCO Core Ranges

<table>
<thead>
<tr>
<th>VCO CORE</th>
<th>( f_{\text{CoreMin}} )</th>
<th>( f_{\text{CoreMax}} )</th>
<th>( C_{\text{CoreMin}} )</th>
<th>( C_{\text{CoreMax}} )</th>
<th>( A_{\text{CoreMin}} )</th>
<th>( A_{\text{CoreMax}} )</th>
</tr>
</thead>
<tbody>
<tr>
<td>VCO1</td>
<td>7500</td>
<td>8600</td>
<td>164</td>
<td>12</td>
<td>299</td>
<td>240</td>
</tr>
<tr>
<td>VCO2</td>
<td>8600</td>
<td>9800</td>
<td>165</td>
<td>16</td>
<td>356</td>
<td>247</td>
</tr>
<tr>
<td>VCO3</td>
<td>9800</td>
<td>10800</td>
<td>158</td>
<td>19</td>
<td>324</td>
<td>224</td>
</tr>
<tr>
<td>VCO4</td>
<td>10800</td>
<td>12000</td>
<td>140</td>
<td>0</td>
<td>383</td>
<td>244</td>
</tr>
<tr>
<td>VCO5</td>
<td>12000</td>
<td>12900</td>
<td>183</td>
<td>36</td>
<td>205</td>
<td>146</td>
</tr>
<tr>
<td>VCO6</td>
<td>12900</td>
<td>13900</td>
<td>155</td>
<td>6</td>
<td>242</td>
<td>163</td>
</tr>
<tr>
<td>VCO7</td>
<td>13900</td>
<td>15000</td>
<td>175</td>
<td>19</td>
<td>323</td>
<td>244</td>
</tr>
</tbody>
</table>

**NOTE**

In the range of 11900 MHz to 12100 MHz, VCO assistance cannot be used, and the settings must be: VCO_SEL = 4, VCO_DACISET_STRT = 300, and VCO_CAPCTRL_STRT = 1. Outside this range, in the partial assist for the VCO calibration, the VCO calibration runs. This means that if the settings are incorrect, the VCO still locks with the correct settings. The only consequence is that the calibration time might be a little longer. The closer the calibration settings are to the true final settings, the faster the VCO calibration will be.
### 7.3.6.2 Determining the VCO Gain

The VCO gain varies between the seven cores and is the lowest at the lowest end of the band and highest at the highest end of each band. For a more accurate estimation, use Table 7:

<table>
<thead>
<tr>
<th>CORE</th>
<th>f1</th>
<th>f2</th>
<th>Kvco1</th>
<th>Kvco2</th>
</tr>
</thead>
<tbody>
<tr>
<td>VCO1</td>
<td>7500</td>
<td>8600</td>
<td>73</td>
<td>114</td>
</tr>
<tr>
<td>VCO2</td>
<td>8600</td>
<td>9800</td>
<td>61</td>
<td>121</td>
</tr>
<tr>
<td>VCO3</td>
<td>9800</td>
<td>10800</td>
<td>98</td>
<td>132</td>
</tr>
<tr>
<td>VCO4</td>
<td>10800</td>
<td>12000</td>
<td>106</td>
<td>141</td>
</tr>
<tr>
<td>VCO5</td>
<td>12000</td>
<td>12900</td>
<td>170</td>
<td>215</td>
</tr>
<tr>
<td>VCO6</td>
<td>12900</td>
<td>13900</td>
<td>172</td>
<td>218</td>
</tr>
<tr>
<td>VCO7</td>
<td>13900</td>
<td>15000</td>
<td>182</td>
<td>239</td>
</tr>
</tbody>
</table>

Based on Table 7, Equation 4 can estimate the VCO gain for an arbitrary VCO frequency of $f_{VCO}$:

$$K_{vco} = K_{vco1} + (K_{vco2} – K_{vco1}) \times (f_{VCO} – f_1) / (f_2 – f_1)$$  \hspace{1cm} (4)

### 7.3.7 Channel Divider

To go below the VCO lower bound of 7.5 GHz, the channel divider can be used. The channel divider consists of four segments, and the total division value is equal to the multiplication of them. Therefore, not all values are valid.

When the channel divider is used, there are limitations on the values. Table 8 shows how these values are implemented and which segments are used.

![Figure 30. Channel Divider](image-url)
### Table 8. Channel Divider Segments

<table>
<thead>
<tr>
<th>EQUIVALENT DIVISION VALUE</th>
<th>FREQUENCY LIMITATION</th>
<th>OutMin (MHz)</th>
<th>OutMax (MHz)</th>
<th>CHDIV[4:0]</th>
<th>SEG0</th>
<th>SEG1</th>
<th>SEG2</th>
<th>SEG3</th>
</tr>
</thead>
<tbody>
<tr>
<td>2</td>
<td>None</td>
<td>3750</td>
<td>7500</td>
<td>0</td>
<td>2</td>
<td>1</td>
<td>1</td>
<td>1</td>
</tr>
<tr>
<td>4</td>
<td></td>
<td>1875</td>
<td>3750</td>
<td>1</td>
<td>2</td>
<td>2</td>
<td>1</td>
<td>1</td>
</tr>
<tr>
<td>6</td>
<td></td>
<td>1250</td>
<td>2500</td>
<td>2</td>
<td>2</td>
<td>3</td>
<td>1</td>
<td>1</td>
</tr>
<tr>
<td>8</td>
<td></td>
<td>937.5</td>
<td>1437.5</td>
<td>3</td>
<td>2</td>
<td>2</td>
<td>2</td>
<td>1</td>
</tr>
<tr>
<td>12</td>
<td></td>
<td>625</td>
<td>958.333</td>
<td>4</td>
<td>2</td>
<td>3</td>
<td>2</td>
<td>1</td>
</tr>
<tr>
<td>16</td>
<td></td>
<td>468.75</td>
<td>718.75</td>
<td>5</td>
<td>2</td>
<td>2</td>
<td>4</td>
<td>1</td>
</tr>
<tr>
<td>24</td>
<td></td>
<td>312.5</td>
<td>479.167</td>
<td>6</td>
<td>2</td>
<td>2</td>
<td>6</td>
<td>1</td>
</tr>
<tr>
<td>32</td>
<td></td>
<td>234.375</td>
<td>359.375</td>
<td>7</td>
<td>2</td>
<td>2</td>
<td>8</td>
<td>1</td>
</tr>
<tr>
<td>48</td>
<td></td>
<td>156.25</td>
<td>239.583</td>
<td>8</td>
<td>2</td>
<td>3</td>
<td>8</td>
<td>1</td>
</tr>
<tr>
<td>64</td>
<td></td>
<td>117.1875</td>
<td>179.6875</td>
<td>9</td>
<td>2</td>
<td>2</td>
<td>8</td>
<td>2</td>
</tr>
<tr>
<td>72</td>
<td></td>
<td>104.167</td>
<td>159.722</td>
<td>10</td>
<td>2</td>
<td>3</td>
<td>6</td>
<td>2</td>
</tr>
<tr>
<td>96</td>
<td></td>
<td>78.125</td>
<td>119.792</td>
<td>11</td>
<td>2</td>
<td>3</td>
<td>8</td>
<td>2</td>
</tr>
<tr>
<td>128</td>
<td></td>
<td>58.594</td>
<td>89.844</td>
<td>12</td>
<td>2</td>
<td>2</td>
<td>8</td>
<td>4</td>
</tr>
<tr>
<td>192</td>
<td></td>
<td>39.0625</td>
<td>59.896</td>
<td>13</td>
<td>2</td>
<td>2</td>
<td>8</td>
<td>6</td>
</tr>
<tr>
<td>256</td>
<td></td>
<td>29.297</td>
<td>44.922</td>
<td>14</td>
<td>2</td>
<td>2</td>
<td>8</td>
<td>8</td>
</tr>
<tr>
<td>384</td>
<td></td>
<td>19.531</td>
<td>29.948</td>
<td>15</td>
<td>2</td>
<td>3</td>
<td>8</td>
<td>8</td>
</tr>
<tr>
<td>512</td>
<td></td>
<td>14.648</td>
<td>22.461</td>
<td>16</td>
<td>2</td>
<td>2</td>
<td>8</td>
<td>16</td>
</tr>
<tr>
<td>768</td>
<td></td>
<td>9.766</td>
<td>14.974</td>
<td>17</td>
<td>2</td>
<td>3</td>
<td>8</td>
<td>16</td>
</tr>
<tr>
<td>Invalid</td>
<td>n/a</td>
<td>n/a</td>
<td>n/a</td>
<td>18-31</td>
<td>n/a</td>
<td>n/a</td>
<td>n/a</td>
<td>n/a</td>
</tr>
</tbody>
</table>

The channel divider is powered up whenever an output (OUTx_MUX) is selected to the channel divider or SysRef, regardless of whether it is powered down or not. When an output is not used, TI recommends selecting the VCO output to ensure that the channel divider is not unnecessarily powered up.

### Table 9. Channel Divider

<table>
<thead>
<tr>
<th>OUTA_MUX</th>
<th>OUTB_MUX</th>
<th>CHANNEL DIVIDER</th>
</tr>
</thead>
<tbody>
<tr>
<td>Channel Divider</td>
<td>X</td>
<td>Powered up</td>
</tr>
<tr>
<td>X</td>
<td>Channel Divider or SYSREF</td>
<td>Powered up</td>
</tr>
<tr>
<td>All Other Cases</td>
<td></td>
<td>Powered down</td>
</tr>
</tbody>
</table>

#### 7.3.8 VCO Doubler

The VCO doubler allows the VCO frequency to be doubled, but it has a limitation of 20 GHz. The doubler can be chosen for output A only with OUTA_MUX. When this is chosen, the VCO2X_EN bit must also be enabled. The doubler can also be used in phase sync mode, provided that OUTB_MUX is not set for the channel divider.

### Table 10. VCO Doubler Programming

<table>
<thead>
<tr>
<th>VCO DOUBLER</th>
<th>PROGRAMMING</th>
</tr>
</thead>
<tbody>
<tr>
<td>Disabled</td>
<td>OUTA_MUX &lt;= 2</td>
</tr>
<tr>
<td></td>
<td>VCO2X_EN = 0</td>
</tr>
<tr>
<td>Enabled</td>
<td>OUTA_MUX = 2</td>
</tr>
<tr>
<td></td>
<td>VCO2X_EN = 1</td>
</tr>
</tbody>
</table>

#### 7.3.9 Output Buffer

The RF output buffer type is open collector and requires an external pullup to Vcc. This component may be a 50-Ω resistor to target 50-Ω output impedance match, or an inductor for higher output power at the expense of the output impedance being far from 50 Ω. If inductor is used, it is recommended to follow with resistive pad for better impedance matching. The current to the output buffer increases for states 0 to 31 and then again from states 48 to 63. States 32 to 47 are redundant and mimic states 16 to 31. If using a resistor, limit the OUTx_PWR setting to 50. Higher settings may actually reduce power due to the voltage drop across the resistor.
### Table 11. OUTx_PWR Recommendations for Resistor Pullup

<table>
<thead>
<tr>
<th>(f_{\text{OUT}})</th>
<th>RECOMMENDATION</th>
<th>COMMENTS</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>HIGHEST POWER</td>
<td>LOWEST NOISE FLOOR</td>
</tr>
<tr>
<td>(10, \text{MHz} \leq f_{\text{OUT}} &lt; 13.3, \text{GHz})</td>
<td>\text{OUTx_PWR} = 50</td>
<td>\text{OUTx_PWR} = 50</td>
</tr>
<tr>
<td>(13.3, \text{GHz} \leq f_{\text{OUT}} \leq 14.3, \text{GHz})</td>
<td>\text{OUTx_PWR} = 15</td>
<td>\text{OUTx_PWR} = 15</td>
</tr>
<tr>
<td>(14.3, \text{GHz} &lt; f_{\text{OUT}} \leq 15, \text{GHz})</td>
<td>\text{OUTx_PWR} = 31</td>
<td>\text{OUTx_PWR} = 20</td>
</tr>
<tr>
<td>(15, \text{GHz} &lt; f_{\text{OUT}} \leq 20, \text{GHz})</td>
<td>\text{OUTx_PWR} = 31</td>
<td>\text{OUTx_PWR} = 20</td>
</tr>
</tbody>
</table>

#### 7.3.10 Power-Down Modes

The LMX2595 can be powered up and down using the CE pin or the POWERDOWN bit. When the device comes out of the powered down state, either by resuming the POWERDOWN bit to zero or by pulling back CE pin HIGH, register R0 must be programmed with FCAL_EN high again to re-calibrate the device.

#### 7.3.11 Phase Synchronization

##### 7.3.11.1 General Concept

The SYNC pin allows one to synchronize the LMX2595 such that the delay from the rising edge of the OSCin signal to the output signal is deterministic. Initially, the devices are locked to the input, but are not synchronized. The user sends a synchronization pulse that is reclocked to the next rising edge of the OSCin pulse. After a given time, \(t_1\), the phase relationship from OSCin to \(f_{\text{OUT}}\) will be deterministic. This time is dominated by the sum of the VCO calibration time, the analog setting time of the PLL loop, and the MASH_RST_CNT if used in fractional mode.

![Diagram of Devices Are Now Synchronized to OSCin Signal](image)

**Figure 31. Devices Are Now Synchronized to OSCin Signal**

When the SYNC feature is enabled, part of the channel divide may be included in the feedback path. This will be referred to as *IncludedDivide*
### Table 12. Included Divide With VCO_PHASE_SYNC = 1

<table>
<thead>
<tr>
<th>OUTx_MUX</th>
<th>CHANNEL DIVIDER</th>
<th>INCLUDED/DIVIDE</th>
</tr>
</thead>
<tbody>
<tr>
<td>OUTB_MUX = 1 (&quot;VCO&quot;)&lt;br&gt;OUTA_MUX = 1 &quot;VCO&quot; or 2 &quot;VCO Doubler&quot;</td>
<td>Don't Care</td>
<td>1</td>
</tr>
<tr>
<td>All Other Valid Conditions</td>
<td>Divisible by 3, but NOT 24 or 192&lt;br&gt;All other values</td>
<td>SEG0 × SEG1 = 6&lt;br&gt;SEG0 × SEG1 = 4</td>
</tr>
</tbody>
</table>

---

**Figure 32. Phase SYNC Diagram**

**7.3.11.2 Categories of Applications for SYNC**

The requirements for SYNC depend on certain setup conditions. In cases that the SYNC is not timing critical, it can be done through software by toggling the VCO_PHASE_SYNC bit from 0 to 1. When it is timing critical, then it must be done through the pin and the setup and hold times for the OSCin pin are critical. Figure 33 gives the different categories.
Figure 33. Determining the SYNC Category
7.3.11.3 Procedure for Using SYNC

This procedure must be used to put the device in SYNC mode.
1. Use the flowchart to determine the SYNC category.
2. Make determinations for OSCin and using SYNC based on the category.
   1. If Category 4, SYNC cannot be performed in this setup.
   2. If category 3, ensure that the maximum \( f_{OSC} \) frequency for SYNC is not violated and there are hardware accommodations to use the SYNC pin.
3. Determine the value of IncludedDivide:
   1. If OUTA_MUX is not channel divider and OUTB_MUX is not channel divider or SysRef, then IncludedDivide = 1.
   2. Otherwise, IncludedDivide = \( 2 \times SEG1 \). In the case that the channel divider is 2, then IncludedDivide=4.
4. If not done already, divide the N-divider and fractional values by IncludedDivide to account for the IncludedDivide.
5. Program the device with the VCO_PHASE_SYNC = 1. Note that this does not count as applying a SYNC to device (for category 2).
6. Apply the SYNC, if required:
   1. If category 2, VCO_PHASE_SYNC can be toggled from 0 to 1. Alternatively, a rising edge can be sent to the SYNC pin and the timing of this is not critical.
   2. If category 3, the SYNC pin must be used, and the timing must be away from the rising edge of the OSCin signal. Toggling the SYNC pin runs VCO calibration when FCAL_EN = 1. If FCAL_EN = 0 then SYNC pin does not function.

7.3.11.4 SYNC Input Pin

The SYNC input pin can be driven either in CMOS or LVDS mode. However, if not using SYNC mode (VCO_PHASE_SYNC = 0), then the INPIN_IGNORE bit must be set to one, otherwise it causes issues with lock detect. If the pin is desired for to be used and VCO_PHASE_SYNC = 1, then set INPIN_IGNORE = 0. LVDS or CMOS mode may be used. LVDS works to 250 mVPP, but is not ensured in production.

7.3.12 Phase Adjust

The MASH_SEED word can use the sigma-delta modulator to shift output signal phase with respect to the input reference. If a SYNC pulse is sent (software or pin) or the MASH is reset with MASH_RST_N, then this phase shift is from the initial phase of zero. If the MASH_SEED word is written to, then this phase is added. Use Equation 5 to calculate the phase shift.

\[
\text{Phase shift in degrees} = 360 \times \left( \frac{\text{MASH\_SEED}}{\text{PLL\_DEN}} \right) \times \left( \frac{\text{IncludedDivide}}{\text{CHDIV}} \right)
\] (5)

Example:

Mash seed = 1
Denominator = 12
Channel divider = 16
Phase shift (VCO_PHASE_SYNC = 0) = 360 \times \left( \frac{1}{12} \right) \times \left( \frac{1}{16} \right) = 1.875 \text{ degrees}
Phase Shift (VCO_PHASE_SYNC = 1) = 360 \times \left( \frac{1}{12} \right) \times \left( \frac{4}{16} \right) = 7.5 \text{ degrees}

There are several considerations with phase shift with MASH_SEED:

- Phase shift can be done with a FRAC_NUM = 0, but MASH_ORDER must be greater than zero. For MASH_ORDER = 1, the phase shifting only occurs when MASH_SEED is a multiple of PLL_DEN.
- For the phase adjust, the condition PLL_DEN > PLL_NUM + MASH_SEED must be satisfied.
- When MASH_SEED and Phase SYNC are used together with IncludedDivide > 1, additional constraints may be necessary to produce a monotonic relationship between MASH_SEED and the phase shift, especially when the VCO frequency is below 10 GHz. These constraints are application specific, but some general guidelines are to reduce modulator order and increase the N divider. One possible guideline is for PLL_N \( \geq 45 \) (2nd order modulator), PLL_N \( \geq 49 \) (3rd Order modulator), PLL_N \( \geq 54 \) (4th Order Modulator).
7.3.13 Fine Adjustments for Phase Adjust and Phase SYNC

Phase SYNC refers to the process of getting the same phase relationship for every power-up cycle and each time assuming that a given programming procedure is followed. However, there are some adjustments that can be made to get the most accurate results. As for the consistency of the phase SYNC, the only source of variation could be if the VCO calibration chooses a different VCO core and capacitor, which can introduce a bimodal distribution with about 10 ps of variation. If this 10 ps is not desirable, then it can be eliminated by reading back the VCO core, capcode, and DACISET values and forcing these values to ensure the same calibration settings every time. The delay through the device varies from part to part and can be on the order of 60 ps. This part to part variation can be calibrated out with the MASH_SEED. The variation in delay through the device also changes on the order of +2.5 ps/°C, but devices on the same board likely have similar temperatures, so this will somewhat track. In summary, the device can be made to have consistent delay through the part and there are means to adjust out any remaining errors with the MASH_SEED. This tends only to be an issue at higher output frequencies when the period is shorter.

7.3.14 Ramping Function

The LMX2595 supports the ability to make ramping waveforms using manual mode or automatic mode. In manual mode, the user defines a step and uses the RampClk and RampDir pins to create the ramp. In automatic mode, the user sets up the ramp with up to two linear segments in advance and the device automatically creates this ramp. Table 13 fields apply in both automatic mode and manual pin mode.

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>RAMP_EN</td>
<td>0 = Disabled</td>
<td>RAMP_EN must be 1 for any ramping functions to work.</td>
</tr>
<tr>
<td></td>
<td>1 = Enabled</td>
<td></td>
</tr>
<tr>
<td>RAMP_MANUAL</td>
<td>0 = Automatic ramping mode</td>
<td>In automatic ramping mode, the ramping is automatic and the clock is based on the phase detector. In manual pin ramping mode, the clock is based on rising edges on the RampClk pin.</td>
</tr>
<tr>
<td></td>
<td>1 = Manual pin ramping mode</td>
<td></td>
</tr>
<tr>
<td>RAMPx_INC</td>
<td>0 to $2^{30} – 1$</td>
<td>This is the amount the fractional numerator is increased for each phase detector cycle in the ramp.</td>
</tr>
<tr>
<td>RAMPx_DLY</td>
<td>0 to 65535</td>
<td>This is the length of the ramp in phase detector cycles.</td>
</tr>
</tbody>
</table>

DEALING WITH VCO CALIBRATION

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>RAMP_THRESH</td>
<td>0 to $\pm 2^{33} – 1$</td>
<td>Whenever the fractional numerator changes this much (either positive or negative) because the VCO was last calibrated, the VCO is forced to recalculate.</td>
</tr>
<tr>
<td>RAMP_TRIG_CAL</td>
<td>0 = Disabled</td>
<td>When enabled, the VCO is forced to recalibrate at the beginning each ramp.</td>
</tr>
<tr>
<td></td>
<td>1 = Enabled</td>
<td></td>
</tr>
<tr>
<td>PLL_DEN</td>
<td>4294967295</td>
<td>In ramping mode, the denominator must be fixed to this forced value of $2^{32} – 1$. However, the effective denominator in ramping mode is $2^{24}$.</td>
</tr>
<tr>
<td>LD_DLY</td>
<td>0</td>
<td>This must be zero to avoid interfering with calibration.</td>
</tr>
</tbody>
</table>

RAMP LIMITS

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>RAMP_LIMIT_LOW</td>
<td>0 to $\pm 2^{33} – 1$</td>
<td>2's complement of the total value of the ramp low and high limits can never go beyond. If this value is exceeded, then the frequency is limited.</td>
</tr>
<tr>
<td>RAMP_LIMIT_HIGH</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
### Table 14. General Restrictions for Ramping

<table>
<thead>
<tr>
<th>RULE</th>
<th>RESTRICTION</th>
<th>EXPLANATION</th>
</tr>
</thead>
<tbody>
<tr>
<td>Phase Detector Frequency</td>
<td>( f_{\text{OSC}} / 2^{\text{CAL_CLK_DIV}} \leq f_{\text{PD}} \leq 125 \text{ MHz} )</td>
<td>Minimum Phase Detector Frequency when Ramping&lt;br&gt;The phase detector frequency cannot be less than the state machine clock frequency, which is calculated from expression on the left-hand side of the inequality. This is satisfied provided there is no division in the input path. However, if the PLL R-divider is used, it is necessary to adjust CAL_CLK_DIV to adjust the state machine clock frequency. This also implies a maximum R divide of 8 this is the maximum value of ( 2^{\text{CAL_CLK_DIV}} ).&lt;br&gt;Maximum Phase Detector Frequency&lt;br&gt;TI recommends to set the phase-detector frequency ( \leq 125 \text{ MHz} ) because, if the phase detector frequency is too high, it can lead to distortion in the ramp. Higher phase-detector frequency may be possible, but this distortion is application specific.</td>
</tr>
</tbody>
</table>

#### 7.3.14.1 Manual Pin Ramping

Manual pin ramping is enabled by setting RAMP_EN = 1 and RAMP_MANUAL = 1. The rising edges are applied to the RampClk pin are reclocked to the phase detector frequency. The RampDir pin controls the size of the change. If a rising edge is seen on the RampClk pin while the VCO is calibrating, then this rising edge is ignored. The frequency for the RampClk must be limited to a frequency of 250 kHz or less, and the rising edge of the RampDir signal must be targeted away from the rising edges of the RampCLK pin.

<table>
<thead>
<tr>
<th>RampDir PIN</th>
<th>STEP SIZE</th>
</tr>
</thead>
<tbody>
<tr>
<td>Low</td>
<td>Add RAMP0_INC</td>
</tr>
<tr>
<td>High</td>
<td>Add RAMP1_INC</td>
</tr>
</tbody>
</table>

#### 7.3.14.1.1 Manual Pin Ramping Example

In this ramping example, assume that we want to use the pins for UP/Down control of the ramp for 10-MHz steps and the phase detector is 100 MHz.

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>RAMP_EN</td>
<td>1 = Enabled</td>
<td></td>
</tr>
<tr>
<td>RAMP_MANUAL</td>
<td>1 = Manual pin ramping mode</td>
<td></td>
</tr>
<tr>
<td>RAMP0_INC</td>
<td>1677722</td>
<td>(10 MHz / (100 MHz) * 16777216 = 1677722 2’s complement = 1677722</td>
</tr>
<tr>
<td>RAMP1_INC</td>
<td>1072064102</td>
<td>(–10 MHz / (100 MHz) * 16777216 = –1677722 2’s complement = 2^{30} – 1677722 = 1072064102</td>
</tr>
<tr>
<td>RAMP_TRIG_CAL</td>
<td>1</td>
<td>Recalibrate at every clock cycle</td>
</tr>
</tbody>
</table>
Figure 34. Step Ramping Example
7.3.14.2 Automatic Ramping

Automatic ramping is enabled when RAMP_EN = 1 and RAMP_MANUAL = 0. The action of programming FCAL = 1 starts the ramping. In this mode, there are two ramps that one can use to set the length and frequency change. In addition to this, there are ramp limits that can be used to create more complicated waveforms.

Automatic ramping can really be divided into two classes depending on if the VCO must calibrate in the middle of the ramping waveform or not. If the VCO can go the entire range without calibrating, this is calibration-free ramping, which is shown in Typical Characteristics. Note that this range is less at hot temperatures and for lower frequency VCOs. This range is not ensured, so margin must be built into the design.

For waveforms that are NOT calibration free, the slew rate of the ramp must be kept less than 250 kHz/µs. Also, for all automatic ramping waveforms, be aware that there is a very small phase disturbance as the VCO crosses over the integer boundary, so one might consider using the input multiplier to avoid these or timing the VCO calibrations at integer boundaries.

### Table 17. Automatic Ramping Field Descriptions

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
</table>
| RAMP_DLY         | 0 = One clock cycle  
                  1 = Two clock cycles         | Normally, the ramp clock is equal to the phase detector frequency.  
                                 When this feature is enabled, it reduces the ramp clock by a factor of 2. |
| RAMP0_LEN        | 0 to 65535   | This is the length of the ramp in clock cycles. Note that the VCO calibration time is added to this time. |
| RAMP1_LEN        | 0 to $2^{30} - 1$ | 2's complement of the value for the ramp increment.                        |
| RAMP0_INC        | 0 to 2    
                  30 – 1           | 2's complement of the value for the ramp increment.                        |
| RAMP0_NEXT       | 0 = RAMP0  
                  1 = RAMP1            | Defines which ramp comes after the current ramp.                           |
| RAMP1_NEXT       | 0 = RAMP0  
                  1 = RAMP1            |                                                                             |
| RAMP0_NEXT_TRIG  | 0 = Timeout counter  
                  1 = Trigger A  
                  2 = Trigger B  
                  3 = Reserved     | Determines what triggers the action of the next ramp occurrence.            |
| RAMP1_NEXT_TRIG  | 0 = Timeout counter  
                  1 = Trigger A  
                  2 = Trigger B  
                  3 = Reserved     |                                                                             |
| RAMP_TRIG_A      | 0 = Disabled  
                  1 = RampClk rising edge  
                  2 = RampDir rising edge  
                  4 = Always triggered  
                  9 = RampClk falling edge  
                  10 = RampDir falling edge | This field defines the ramp trigger.                                     |
| RAMP_TRIG_B      | 0 = Disabled  
                  1 = Enabled          |                                                                             |
| RAMP_RST         | 0 = Disabled  
                  1 = Enabled          | Enabling this bit causes the ramp to reset to the original value when the ramping started. This is useful for roundoff errors. |
| RAMP_BURST_COUNT | 0 to 8191    | This is the number the ramping pattern repeats and only applies for a terminating ramping pattern. |
| RAMP_BURST_TRIG  | 0 = Ramp Transition  
                  1 = Trigger A  
                  2 = Trigger B  
                  3 = Reserved     | This defines what causes the RAMP_COUNT to increment.                      |
7.3.14.2.1 Automatic Ramping Example (Triangle Wave)

Suppose user wants to generate a sawtooth ramp that goes from 8 to 10 GHz in 2 ms (including calibration breaks) with a phase-detector frequency of 50 MHz. Divide this into segments of 50 MHz where the VCO ramps for 25 µs, then calibrates for 25 µs, for a total of 50 µs. There would therefore be 40 such segments which span over a 2-GHz range and would take 2 ms, including calibration time.

Table 18. Sawtooth Ramping Example

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>RAMP_EN</td>
<td>1</td>
<td>Enabled</td>
</tr>
<tr>
<td>RAMP_MANUAL</td>
<td>0</td>
<td>Automatic ramping mode</td>
</tr>
<tr>
<td>RAMP_TRIG_CAL</td>
<td>0</td>
<td>Disabled</td>
</tr>
<tr>
<td>RAMP_THresh</td>
<td>16777216 (= 50-MHz ramp_thresh)</td>
<td>50 MHz / 50 MHz × 2^24 = 16777216</td>
</tr>
<tr>
<td>RAMP_DLY</td>
<td>0</td>
<td>1 clock cycle</td>
</tr>
<tr>
<td>RAMPx_LEN</td>
<td>50000</td>
<td>1000 µs × 50 MHz = 50000</td>
</tr>
<tr>
<td>RAMP0_INC</td>
<td>13422</td>
<td>(2000 MHz) / (50 MHz) × 2^24 / 50000 = 13422</td>
</tr>
<tr>
<td>RAMP1_INC</td>
<td>1073728402</td>
<td>(−2000 MHz) / (50 MHz) × 2^24 / 50000 = −13422</td>
</tr>
<tr>
<td>RAMP0_NEXT</td>
<td>1</td>
<td>RAMP1</td>
</tr>
<tr>
<td>RAMP1_NEXT</td>
<td>0</td>
<td>RAMP0</td>
</tr>
<tr>
<td>RAMPx_NEXT_TRIG</td>
<td>0</td>
<td>Timeout counter</td>
</tr>
<tr>
<td>RAMP_TRIG_x</td>
<td>0</td>
<td>Disabled</td>
</tr>
<tr>
<td>RAMP0_RST</td>
<td>1</td>
<td>Enabled</td>
</tr>
<tr>
<td>RAMP1_RST</td>
<td>0</td>
<td>Disabled</td>
</tr>
<tr>
<td>RAMP_BURST_COUNT</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>RAMP_BURST_TRIG</td>
<td>0</td>
<td>Ramp Transition</td>
</tr>
</tbody>
</table>

NOTE

To calculate ramp_scale_count and ramp_dly_cnt, remember that the desired calibration time is 25 µs.

Figure 35. Triangle Waveform Example
7.3.15 SYSREF

The LMX2595 can generate a SYSREF output signal that is synchronized to \( f_{\text{OUT}} \) with a programmable delay. This output can be a single pulse, series of pulses, or a continuous stream of pulses. To use the SYSREF capability, the PLL must first be placed in SYNC mode with VCO_PHASE_SYNC = 1.

As Figure 36 shows, the SYSREF feature uses IncludedDivide and SYSREF_DIV_PRE divider to generate \( f_{\text{INTERPOLATOR}} \). This frequency is used for reclocking of the rising and falling edges at the SysRefReq pin. In master mode, the \( f_{\text{INTERPOLATOR}} \) is further divided by \( 2 \times \text{SYSREF}\_\text{DIV} \) to generate finite series or continuous stream of pulses.

### Table 19. SYSREF Setup

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>( f_{\text{VCO}} )</td>
<td>7.5</td>
<td></td>
<td>15</td>
<td>GHz</td>
</tr>
<tr>
<td>( f_{\text{INTERPOLATOR}} )</td>
<td>0.8</td>
<td></td>
<td>1.5</td>
<td>GHz</td>
</tr>
<tr>
<td>IncludedDivide</td>
<td>4 or 6</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYSREF_DIV_PRE</td>
<td>1, 2, or 4</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYSREF_DIV</td>
<td>4,6,8,...,4098</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>( f_{\text{INTERPOLATOR}} )</td>
<td>( \frac{f_{\text{VCO}}}{(\text{IncludedDivide} \times \text{SYSREF}_\text{DIV}_\text{PRE})} )</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>( f_{\text{SYSREF}} )</td>
<td>( \frac{f_{\text{INTERPOLATOR}}}{(2 \times \text{SYSREF}_\text{DIV})} )</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Delay step size</td>
<td>9</td>
<td></td>
<td>n/a</td>
<td>ps</td>
</tr>
<tr>
<td>Pulses for pulsed mode (SYSREF_PULSE_CNT)</td>
<td>0</td>
<td></td>
<td>15</td>
<td>n/a</td>
</tr>
</tbody>
</table>

The delay can be programmed using the JESD\_DAC1\_CTRL, JESD\_DAC2\_CTRL, JESD\_DAC3\_CTRL, and JESD\_DAC4\_CTRL words. By concatenating these words into a larger word called "SYSREFPHASESHIFT", the relative delay can be found. The sum of these words should always be 63.
### Table 20. SysRef Delay

<table>
<thead>
<tr>
<th>SYSREFPHASESHIFT</th>
<th>DELAY</th>
<th>JESD_DAC1</th>
<th>JESD_DAC2</th>
<th>JESD_DAC3</th>
<th>JESD_DAC4</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>Minimum</td>
<td>36</td>
<td>27</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>...</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>36</td>
<td>0</td>
<td>63</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>...</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>99</td>
<td>0</td>
<td>0</td>
<td>63</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>100</td>
<td>0</td>
<td>0</td>
<td>62</td>
<td>1</td>
<td>0</td>
</tr>
<tr>
<td>...</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>161</td>
<td>0</td>
<td>0</td>
<td>1</td>
<td>62</td>
<td>0</td>
</tr>
<tr>
<td>162</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>63</td>
<td>0</td>
</tr>
<tr>
<td>163</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>62</td>
<td>0</td>
</tr>
<tr>
<td>225</td>
<td>63</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>226</td>
<td>62</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>247</td>
<td>Maximum</td>
<td>41</td>
<td>22</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>&gt; 247</td>
<td>Invalid</td>
<td>Invalid</td>
<td>Invalid</td>
<td>Invalid</td>
<td>Invalid</td>
</tr>
</tbody>
</table>

### 7.3.15.1 Programmable Fields

Table 21 has the programmable fields for the SYSREF functionality.

### Table 21. SYSREF Programming Fields

<table>
<thead>
<tr>
<th>FIELD</th>
<th>PROGRAMMING</th>
<th>DEFAULT</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>SYSREF_EN</td>
<td>0: Disabled</td>
<td>0</td>
<td>Enables the SYSREF mode. SYSREF_EN should be 1 if and only if OUTB_MUX = 2 (SysRef).</td>
</tr>
<tr>
<td></td>
<td>1: Enabled</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYSREF_DIV_PRE</td>
<td>1: DIV1</td>
<td></td>
<td>The output of this divider is $f_{INTERPOLATOR}$.</td>
</tr>
<tr>
<td></td>
<td>2: DIV2</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>4: DIV4</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Other states: invalid</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYSREF_REPEAT</td>
<td>0: Master mode</td>
<td>0</td>
<td>In master mode, the device creates a series of SYSREF pulses. In repeater mode, SYSREF pulses are generated with the SysRefReq pin.</td>
</tr>
<tr>
<td></td>
<td>1: Repeater mode</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYSREF_PULSE</td>
<td>0: Continuous mode</td>
<td>0</td>
<td>Continuous mode continuously makes SYSREF pulses, where pulsed mode makes a series of SYSREF_PULSE_CNT pulses.</td>
</tr>
<tr>
<td></td>
<td>1: Pulsed mode</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYSREF_PULSE_CNT</td>
<td>0 to 15</td>
<td>4</td>
<td>In the case of using pulsed mode, this is the number of pulses. Setting this to zero is an allowable, but not practical state.</td>
</tr>
<tr>
<td>SYSREF_DIV</td>
<td>0: Divide by 4</td>
<td>0</td>
<td>This is one of the dividers between the VCO and SysRef output used in master mode.</td>
</tr>
<tr>
<td></td>
<td>1: Divide by 6</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>2: Divide by 8</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>2047: Divide by 4098</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
7.3.15.2 Input and Output Pin Formats

7.3.15.2.1 Input Format for SYNC and SysRefReq Pins
These pins are single-ended, but a differential signal can be converted to drive them. In the LVDS mode, if the INPIN_FMT is set to LVDS mode, then the bias level can be adjusted with INPIN_LVL and the hysteresis can be adjusted with INPIN_HYST.

![Figure 37. Driving SYNC/SYSREF With Differential Signal](image1)

7.3.15.2.2 SYSREF Output Format
The SYSREF output comes in differential format through RFoutB. This will have a minimum voltage of about 2.3 V and a maximum of 3.3 V. If DC coupling cannot be used, there are two strategies for AC coupling.

![Figure 38. SYSREF Output](image2)

1. Send a series of pulses to establish a DC-bias level across the AC-coupling capacitor.
2. Establish a bias voltage at the data converter that is below the threshold voltage by using a resistive divider.
7.3.15.3 Examples

The SysRef can be used in a repeater mode (SYSREF_REPEAT = 1), which just echos the SysRefReq pin, after being reclocked to the $f_{\text{INTERPOLATOR}}$ frequency and then $f_{\text{OUT}}$ (from RFoutA).

In master mode (SYSREF_REPEAT = 0), rising and falling edges at the SysRefReq pin are first reclocked to the $f_{\text{OSC}}$, then $f_{\text{INTERPOLATOR}}$, and finally to $f_{\text{OUT}}$. A programmable number of pulses is generated with a frequency equal to $f_{\text{VCO}} / (2 \times \text{IncludedDivide} \times \text{SYSREF_DIV_PRE} \times \text{SYSREF_DIV})$. In continuous mode (SYSREF_PULSE = 0), the SysRefReq pin is held high to generate a continuous stream of pulses. In pulse mode (SYSREF_PULSE = 1), a finite number of pulses determined by SYSREF_PULSE_CNT is sent for each rising edge of the SysRefReq pin.
7.3.15.4 SYSREF Procedure

To use SYSREF, do the these steps:

1. Put the device in SYNC mode using the procedure already outlined.
2. Figure out IncludedDivide the same way it is done for SYNC mode.
3. Calculate the SYSREF_DIV_PRE value such that the interpolator frequency \( f_{\text{INTERPOLATOR}} \) is in the range of 800 to 1500 MHz. \( f_{\text{INTERPOLATOR}} = f_{\text{VCO}}/\text{IncludedDivide}/\text{SYSREF_DIV_PRE} \). Make this frequency a multiple of \( f_{\text{OSC}} \) if possible.
4. If using continuous mode (SYSREF_PULSE = 0), ensure the SysRefReq pin is high.
5. If using pulse mode (SYSREF_PULSE = 1), set up the pulse count as desired. Pulses are created by toggling the SysRefReq pin.
6. Adjust the delay between the RFoutA and RFoutB signal using the JESD_DACx_CTL fields.

7.3.16 SysRefReq Pin

The SysRefReq pin can be used in CMOS all the time, or LVDS mode is also optional if SYSREF_REPEAT = 1. LVDS mode cannot be used in master mode.

7.4 Device Functional Modes

Although there are a vast number of ways to configure this device, only one is really functional.

<table>
<thead>
<tr>
<th>MODE</th>
<th>DESCRIPTION</th>
<th>SOFTWARE SETTINGS</th>
</tr>
</thead>
<tbody>
<tr>
<td>RESET</td>
<td>Registers are held in their reset state. This device does have a power on</td>
<td>RESET = 1, POWERDOWN = 0</td>
</tr>
<tr>
<td></td>
<td>reset, but it is good practice to also do a software reset if there is any</td>
<td></td>
</tr>
<tr>
<td></td>
<td>possibility of noise on the programming lines, especially if there is</td>
<td></td>
</tr>
<tr>
<td></td>
<td>sharing with other devices. Also realize that there are registers not</td>
<td></td>
</tr>
<tr>
<td></td>
<td>disclosed in the data sheet that are reset as well.</td>
<td></td>
</tr>
<tr>
<td>POWERDOWN</td>
<td>Device is powered down.</td>
<td>POWERDOWN = 1 or CE Pin = Low</td>
</tr>
<tr>
<td>Normal operating mode</td>
<td>This is used with at least one output on as a frequency synthesizer.</td>
<td></td>
</tr>
<tr>
<td>SYNC mode</td>
<td>This is used where part of the channel divider is in the feedback path</td>
<td>VCO_PHASE_SYNC = 1</td>
</tr>
<tr>
<td></td>
<td>to ensure deterministic phase.</td>
<td></td>
</tr>
<tr>
<td>SYSREF mode</td>
<td>In this mode, RFoutB is used to generate pulses for SYSREF.</td>
<td>VCO_PHASE_SYNC = 1, SYSREF_EN = 1</td>
</tr>
</tbody>
</table>
7.5 Programming

The LMX2595 is programmed using 24-bit shift registers. The shift register consists of a R/W bit (MSB), followed by a 7-bit address field and a 16-bit data field. For the R/W bit, 0 is for write, and 1 is for read. The address field ADDRESS[6:0] is used to decode the internal register address. The remaining 16 bits form the data field DATA[15:0]. While CSB is low, serial data is clocked into the shift register upon the rising edge of clock (data is programmed MSB first). When CSB goes high, data is transferred from the data field into the selected register bank. See Figure 1 for timing details.

7.5.1 Recommended Initial Power-Up Sequence

For the most reliable programming, TI recommends this procedure:
1. Apply power to device.
2. Program RESET = 1 to reset registers.
3. Program RESET = 0 to remove reset.
4. Program registers as shown in the register map in REVERSE order from highest to lowest.
5. Wait 10 ms.
6. Program register R0 one additional time with FCAL_EN = 1 to ensure that the VCO calibration runs from a stable state.

7.5.2 Recommended Sequence for Changing Frequencies

The recommended sequence for changing frequencies is as follows:
1. Change the N-divider value.
2. Program the PLL numerator and denominator.
3. Program FCAL_EN (R0[3]) = 1.

7.5.3 General Programming Requirements

Follow these requirements when programming the device:
1. For register bits that do not have field names in Table 24, it is necessary to program these values just as shown in the register map.
2. Not all registers need to be programmed. Refer to Table 23 for details.
3. Power-on-reset register values may not be optimal, so it is always necessary to program all of the required registers after powering on the device. Note that the ‘Reset’ column in register descriptions is the power-on-reset value.

<table>
<thead>
<tr>
<th>Registers</th>
<th>Function</th>
<th>Comment</th>
</tr>
</thead>
<tbody>
<tr>
<td>R107 – R112</td>
<td>Readback</td>
<td>These registers are for readback only and do not need to be programmed.</td>
</tr>
<tr>
<td>R79 – R106</td>
<td>Ramping</td>
<td>If ramping function is not used (RAMP_EN = 0), then these registers do not need to be programmed.</td>
</tr>
<tr>
<td>R0 – R78</td>
<td>General</td>
<td>These registers need to be programmed for all scenarios.</td>
</tr>
</tbody>
</table>
### 7.6 Register Maps

#### Table 24. Full Register Map

| R/W | A6 | A5 | A4 | A3 | A2 | A1 | A0 | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|----|----|----|----|----|----|----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| R0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R1  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R2  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   |
| R3  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 0   | 1   | 0   | 0   | 0   |
| R4  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R5  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   |
| R6  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1   | 0   | 1   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R7  | 0  | 0  | 0  | 0  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 0   | 1   | 0   | 1   | 0   | 0   |
| R8  | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 1   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R9  | 0  | 0  | 0  | 0  | 0  | 1  | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R10 | 0  | 0  | 0  | 0  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 1   | 0   | 0   | 0   | 0   |
| R11 | 0  | 0  | 0  | 0  | 0  | 1  | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R12 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R13 | 0  | 0  | 0  | 0  | 0  | 0  | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R14 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R15 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 0   | 1   | 0   | 0   | 0   | 0   |
| R16 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R17 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R18 | 0  | 0  | 0  | 0  | 0  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   |
| R19 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R20 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R21 | 0  | 0  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   |
## Register Maps (continued)

### Table 24. Full Register Map (continued)

| R/W | A6 | A5 | A4 | A3 | A2 | A1 | A0 | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|----|----|----|----|----|----|----|-----|-----|-----|-----|-----|-----|----|----|----|----|----|----|----|----|----|
| R22 | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  |
| R23 | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  |
| R24 | 0  | 0  | 0  | 1  | 1  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 0  | 0  | 1  | 1  | 0  | 1  | 0  |
| R25 | 0  | 0  | 0  | 1  | 1  | 1  | 0  | 0   | 0   | 1   | 1   | 1   | 1   | 1   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   |
| R26 | 0  | 0  | 0  | 1  | 1  | 0  | 1  | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 1   | 0   | 1   | 1   | 1   | 0   | 0   | 0   |
| R27 | 0  | 0  | 0  | 1  | 1  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   |
| R28 | 0  | 0  | 0  | 1  | 1  | 1  | 0  | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 1   | 0   | 0   | 0   | 1   | 0   | 0   |
| R29 | 0  | 0  | 0  | 1  | 1  | 1  | 0  | 1   | 0   | 0   | 1   | 1   | 0   | 0   | 1   | 1   | 0   | 0   | 1   | 1   | 0   |
| R30 | 0  | 0  | 0  | 1  | 1  | 1  | 0  | 1   | 1   | 0   | 0   | 0   | 1   | 1   | 1   | 0   | 0   | 1   | 1   | 0   | 0   |
| R31 | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 1   | 1   | 0   | 1   | 1   | 0   |
| R32 | 0  | 0  | 0  | 1  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 0   | 1   | 0   | 0   | 1   | 1   |
| R33 | 0  | 0  | 0  | 1  | 0  | 0  | 0   | 0   | 1   | 0   | 0   | 0   | 1   | 1   | 1   | 1   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 1   |
| R34 | 0  | 0  | 0  | 1  | 0  | 0  | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | PLL_N[18:16] |
| R35 | 0  | 0  | 0  | 1  | 0  | 0  | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   |
| R36 | 0  | 0  | 0  | 1  | 0  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   |
| R37 | 0  | 0  | 0  | 1  | 0  | 0  | 1   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R38 | 0  | 0  | 0  | 1  | 0  | 0  | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R39 | 0  | 0  | 0  | 1  | 0  | 0  | 1   | 1   | 1   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R40 | 0  | 0  | 0  | 1  | 0  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R41 | 0  | 0  | 0  | 1  | 0  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R42 | 0  | 0  | 0  | 1  | 0  | 0  | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R43 | 0  | 0  | 0  | 1  | 0  | 1  | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R44 | 0  | 0  | 0  | 1  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R45 | 0  | 0  | 0  | 1  | 0  | 1  | 1   | 0   | 1   | 1   | 1   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 1   | 1   | 1   |
| R46 | 0  | 0  | 0  | 1  | 0  | 1  | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 1   | 1   | 1   | 1   |

**Register Map Descriptions:**
- **R22, R23, R24, R25, R26:** Various control bits for different functionalities.
- **R27, R28, R29, R30, R31:** Register for voltage control and configuration.
- **R32, R33, R34, R35, R36:** Registers for PLL configuration and control.
- **R37:** MASH configuration bit for seed selection.
- **R38, R39, R40, R41, R42, R43, R44:** Additional control registers for various other functions.
- **R45, R46:** Registers for output power control.

These registers control various aspects of the LMX2595, including power, voltage, and PLL configurations.
## Register Maps (continued)

### Table 24. Full Register Map (continued)

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<td>JESD_DAC1_CTRL</td>
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</tbody>
</table>

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## Table 24. Full Register Map (continued)

| R/W | A6 | A5 | A4 | A3 | A2 | A1 | A0 | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|----|----|----|----|----|----|----|-----|-----|-----|-----|-----|-----|----|----|----|----|----|----|----|----|----|----|----|
| R74 | 0  | 1  | 0  | 0  | 1  | 0  | 1  | 0   |     |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |
| R75 | 0  | 1  | 0  | 0  | 1  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   |    |    |    |    |    |    |    |    |    |    |    |
| R76 | 0  | 1  | 0  | 0  | 1  | 1  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   |    |    |    |    |    |    |    |    |    |    |    |
| R77 | 0  | 1  | 0  | 0  | 1  | 1  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   |    |    |    |    |    |    |    |    |    |    |    |
| R78 | 0  | 1  | 0  | 0  | 1  | 1  | 1  | 0   | 0   | 0   | 0   | 0   | RAM_P_THRESH[32] | 0 | QUIC_K_RECAL_L_EN | VCO_CAPCTRL_STRT | 1 |
| R79 | 0  | 1  | 0  | 0  | 1  | 1  | 1  | 1   |     |     |     |     |     | RAMP_THRESH[31:16] |    |    |    |    |    |    |    |    |    |    |    |
| R80 | 0  | 1  | 0  | 1  | 0  | 0  | 0  | 0   |     |     |     |     |     | RAMP_THRESH[15:0] |    |    |    |    |    |    |    |    |    |    |    |
| R81 | 0  | 1  | 0  | 1  | 0  | 0  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R82 | 0  | 1  | 0  | 1  | 0  | 0  | 1  | 0   |     |     |     |     |     | RAMP_LIMIT_HIGH[31:16] |    |    |    |    |    |    |    |    |    |    |    |
| R83 | 0  | 1  | 0  | 1  | 0  | 0  | 1  | 1   |     |     |     |     |     | RAMP_LIMIT_HIGH[15:0] |    |    |    |    |    |    |    |    |    |    |    |
| R84 | 0  | 1  | 0  | 1  | 0  | 1  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R85 | 0  | 1  | 0  | 1  | 0  | 1  | 0  | 1   |     |     |     |     |     | RAMP_LIMIT_LOW[31:16] |    |    |    |    |    |    |    |    |    |    |    |
| R86 | 0  | 1  | 0  | 1  | 0  | 1  | 1  | 0   |     |     |     |     |     | RAMP_LIMIT_LOW[15:0] |    |    |    |    |    |    |    |    |    |    |    |
| R87 | 0  | 1  | 0  | 1  | 0  | 1  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R88 | 0  | 1  | 0  | 1  | 1  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R89 | 0  | 1  | 0  | 1  | 1  | 0  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R90 | 0  | 1  | 0  | 1  | 1  | 0  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R91 | 0  | 1  | 0  | 1  | 1  | 0  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R92 | 0  | 1  | 0  | 1  | 1  | 1  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R93 | 0  | 1  | 0  | 1  | 1  | 1  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R94 | 0  | 1  | 0  | 1  | 1  | 1  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R95 | 0  | 1  | 0  | 1  | 1  | 1  | 1  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R96 | 0  | 1  | 1  | 0  | 0  | 0  | 0  | 0   | RAMP_BURST_EN |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |
|     |    |    |    |    |    |    |    |    | RAMP_BURST_COUNT |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |
## Table 24. Full Register Map (continued)

| R/W | A6 | A5 | A4 | A3 | A2 | A1 | A0 | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|----|----|----|----|----|----|----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| R97 | 0  | 1  | 1  | 0  | 0  | 0  | 0  | 1   | RAMP0_RS T | 0   | 0   | 0   | 1   | RAMP_TRIGB | RAMP_TRIGA | 0   | RAMP_BUR ST_TRIG |
| R98 | 0  | 1  | 1  | 0  | 0  | 0  | 1  | 0   |    | RAMP0_INC[29:16] | 0   | RAMP0_D L Y |
| R99 | 0  | 1  | 1  | 0  | 0  | 0  | 1  | 1   | RAMP0_INC[15:0] |
| R100| 0  | 1  | 1  | 0  | 0  | 1  | 0  | 0   | RAMP0_LEN |
| R101| 0  | 1  | 1  | 0  | 0  | 1  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | RAMP0_LEN |
| R102| 0  | 1  | 1  | 0  | 0  | 1  | 1  | 0   | 0   | 0   | RAMP0_INC[29:16] |
| R103| 0  | 1  | 1  | 0  | 0  | 1  | 1  | 1   | RAMP0_INC[15:0] |
| R104| 0  | 1  | 1  | 0  | 1  | 0  | 0  | 0   | RAMP0_LEN |
| R105| 0  | 1  | 1  | 0  | 0  | 0  | 0  | 1   | RAMP_DLY_CNT |
| R106| 0  | 1  | 1  | 0  | 0  | 1  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R107| 0  | 1  | 1  | 0  | 0  | 1  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R108| 0  | 1  | 1  | 0  | 1  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R109| 0  | 1  | 1  | 0  | 1  | 1  | 0  | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R110| 0  | 1  | 1  | 0  | 1  | 1  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R111| 0  | 1  | 1  | 0  | 0  | 1  | 1  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
| R112| 0  | 1  | 1  | 0  | 0  | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |
### 7.6.1 General Registers R0, R1, & R7

#### Figure 41. Registers Excluding Address

<table>
<thead>
<tr>
<th>Address</th>
<th>D15</th>
<th>D14</th>
<th>D13</th>
<th>D12</th>
<th>D11</th>
<th>D10</th>
<th>D9</th>
<th>D8</th>
<th>D7</th>
<th>D6</th>
<th>D5</th>
<th>D4</th>
<th>D3</th>
<th>D2</th>
<th>D1</th>
<th>D0</th>
</tr>
</thead>
<tbody>
<tr>
<td>R0</td>
<td>VCO_PHASESYNC</td>
<td>OUT_MUTE</td>
<td>FCAL_HPFD_ADJ</td>
<td>FCAL_LPFD_ADJ</td>
<td>FCAL_EN</td>
<td>MUXOUT_LD_SEL</td>
<td>RESET</td>
<td>POWERDOWN</td>
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<td></td>
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<td></td>
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<td></td>
</tr>
<tr>
<td>R1</td>
<td>OUT_FORCE</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
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<td>0</td>
<td>0</td>
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<tr>
<td>R7</td>
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<td>0</td>
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</tbody>
</table>

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### Table 25. Field Descriptions

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
</table>
| R0[15]   | RAMP_EN | R/W  | 0     | 0: Disable frequency ramping mode  
1: Enable frequency ramping mode |
| R0[14]   | VCO_PHASESYNC | R/W  | 0     | 0: Disable phase SYNC mode  
1: Enable phase SYNC mode |
| R0[9]    | OUT_MUTE | R/W  | 0     | Mute the outputs when the VCO is calibrating.  
0: Disabled. If disabled, also be sure to enable OUT_FORCE  
1: Enabled. If enabled, also be sure to disable OUT_FORCE |
| R0[8:7]  | FCAL_HPFD_ADJ | R/W  | 0     | Set this field in accordance to the phase-detector frequency for  
onimal VCO calibration.  
0: fPD ≤ 100 MHz  
1: 100 MHz < fPD ≤ 150 MHz  
2: 150 MHz < fPD ≤ 200 MHz  
3: fPD > 200 MHz |
| R0[6:5]  | FCAL_LPFD_ADJ | R/W  | 0     | Set this field in accordance to the phase detector frequency for  
onimal VCO calibration.  
0: fPD ≥ 10 MHz  
1: 10 MHz > fPD ≥ 5 MHz  
2: 5 MHz > fPD ≥ 2.5 MHz  
3: fPD < 2.5 MHz |
| R0[3]    | FCAL_EN | R/W  | 0     | Enable the VCO frequency calibration. Also note that the action  
of programming this bit to a 1 activates the VCO calibration |
| R0[2]    | MUXOUT_LD_SEL | R/W  | 0     | Selects the state of the function of the MUXOut pin  
0: Readback  
1: Lock detect |
| R0[1]    | RESET | R/W  | 0     | Resets and holds all state machines and registers to default  
value.  
0: Normal operation  
1: Reset |
| R0[0]    | POWERDOWN | R/W  | 0     | Powers down entire device  
0: Normal operation  
1: Powered down |
| R1[2:0]  | CAL_CLK_DIV | R/W  | 3     | Sets divider for VCO calibration state machine clock based on  
input frequency.  
0: Divide by 1. Use fOSC ≤ 200 MHz  
1: Divide by 2. Use fOSC ≤ 400 MHz  
2: Divide by 4. Use fOSC ≤ 800 MHz  
3: Divide by 8. All fOSC  
If user is not concerned with lock time, it is recommended to set  
this value to 3. By slowing down the VCO calibration, the best  
and most repeatable VCO phase noise can be attained |
| R7[14]   | OUT_FORCE | R/W  | 0     | Works with OUT_MUTE in disabling outputs when VCO  
calibrating. |
7.6.2 Input Path Registers

**Figure 42. Registers Excluding Address**

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R9[12]</td>
<td>OSC_2X</td>
<td>R/W</td>
<td>0</td>
<td>Low-noise OSCin frequency doubler. 0: Disabled 1: Enabled</td>
</tr>
<tr>
<td>R10[11:7]</td>
<td>MULT</td>
<td>R/W</td>
<td>1</td>
<td>Programmable input frequency multiplier 0.2, 8-31: Reserved 1: Byapss 3: 3X ... 7: 7X</td>
</tr>
<tr>
<td>R12[11:0]</td>
<td>PLL_R_PRE</td>
<td>R/W</td>
<td>1</td>
<td>Programmable input path divider before the programmable input frequency multiplier.</td>
</tr>
</tbody>
</table>

7.6.3 Charge Pump Registers (R13, R14)

**Figure 43. Registers Excluding Address**

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R14[6:4]</td>
<td>CPG</td>
<td>R/W</td>
<td>7</td>
<td>Effective charge-pump current. This is the sum of up and down currents. 0: 0 mA 1: 6 mA 2: Reserved 3: 12 mA 4: 3 mA 5: 9 mA 6: Reserved 7: 15 mA</td>
</tr>
</tbody>
</table>
### 7.6.4 VCO Calibration Registers

#### Figure 44. Registers Excluding Address

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R4[15:8]</td>
<td>ACAL_CMP_DLY</td>
<td>R/W</td>
<td>10</td>
<td>VCO amplitude calibration delay. Lowering this value can speed up VCO calibration, but lowering it too much may degrade VCO phase noise. The minimum allowable value for this field is 10 and this allows the VCO to calibrate to the correct frequency for all scenarios. To yield the best and most repeatable VCO phase noise, this relationship should be met: ( \text{ACAL_CMP_DLY} &gt; \frac{\text{CAL_CLK_DIV}}{10 \text{ MHz}} ), where ( \text{CAL_CLK_DIV} ) and ( \text{Fosc} ) is the input reference frequency. If calibration time is of concern, then it is recommended to set this register to ( \geq 25. )</td>
</tr>
<tr>
<td>R8[14]</td>
<td>VCO_DACISET_FORCE</td>
<td>R/W</td>
<td>0</td>
<td>This forces the VCO_DACISET value</td>
</tr>
<tr>
<td>R8[11]</td>
<td>VCO_CAPCTRL_FORCE</td>
<td>R/W</td>
<td>0</td>
<td>This forces the VCO_CAPCTRL value</td>
</tr>
<tr>
<td>R16[0:8]</td>
<td>VCO_DACISET</td>
<td>R/W</td>
<td>128</td>
<td>This sets the final amplitude for the VCO calibration in the case that amplitude calibration is forced.</td>
</tr>
<tr>
<td>R17[0:8]</td>
<td>VCO_DACISET_STRT</td>
<td>R/W</td>
<td>250</td>
<td>This sets the initial starting point for the VCO amplitude calibration.</td>
</tr>
<tr>
<td>R19[0:7]</td>
<td>VCO_CAPCTRL</td>
<td>R/W</td>
<td>183</td>
<td>This sets the final VCO band when VCO_CAPCTRL is forced.</td>
</tr>
<tr>
<td>R20[13:11]</td>
<td>VCO_SEL</td>
<td>R/W</td>
<td>7</td>
<td>This sets VCO start core for calibration and the VCO when it is forced.</td>
</tr>
<tr>
<td>R20[10]</td>
<td>VCO_SEL_FORCE</td>
<td>R/W</td>
<td>0</td>
<td>This forces the VCO to use the core specified by VCO_SEL. It is intended mainly for diagnostic purposes.</td>
</tr>
</tbody>
</table>

**Legend:** R/W = Read/Write; R = Read only; \(-n\) = value after reset
### 7.6.5 N Divider, MASH, and Output Registers

#### Figure 45. Registers Excluding Address

<table>
<thead>
<tr>
<th>Location</th>
<th>Field Description</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R34[2:0]</td>
<td>PLL_N</td>
<td>R/W</td>
<td>100</td>
<td>The PLL_N divider value is in the feedback path and divides the VCO frequency.</td>
</tr>
<tr>
<td>R36[15:0]</td>
<td>MASH_SEED_EN</td>
<td>R/W</td>
<td>0</td>
<td>Enabling this bit allows the to be applied to shift the phase at the output or optimize spurs.</td>
</tr>
<tr>
<td>R37[15:8]</td>
<td>PFD_DLY_SEL</td>
<td>R/W</td>
<td>2</td>
<td>The PFD_DLY_SEL must be adjusted in accordance to the N-divider value. This is with the functional description for the N-divider.</td>
</tr>
<tr>
<td>R40[15:0]</td>
<td>PLL_DEN[15:0]</td>
<td>R/W</td>
<td>0</td>
<td>The initial state of the MASH engine first accumulator. Can be used to shift phase or optimize fractional spurs. Every time the field is programmed, it ADDS this MASH seed to the existing one. To reset it, use the MASH_RESET_N bit.</td>
</tr>
<tr>
<td>R42[15:0]</td>
<td>PLL_NUM</td>
<td>R/W</td>
<td>0</td>
<td>The fractional numerator</td>
</tr>
<tr>
<td>R44[13:8]</td>
<td>OUTA_PWR</td>
<td>R/W</td>
<td>31</td>
<td>Adjusts output power. Higher numbers give more output power to a point, depending on the pullup component used.</td>
</tr>
<tr>
<td>R44[7:6]</td>
<td>OUTB_PD</td>
<td>R/W</td>
<td>1</td>
<td>Powers down output B</td>
</tr>
<tr>
<td>R44[5:4]</td>
<td>OUTA_PD</td>
<td>R/W</td>
<td>0</td>
<td>Powers down output A</td>
</tr>
<tr>
<td>R44[3:0]</td>
<td>MASH_RESET_N</td>
<td>R/W</td>
<td>1</td>
<td>Resets MASH circuitry to an initial state</td>
</tr>
<tr>
<td>R44[2:0]</td>
<td>MASH_ORDER</td>
<td>R/W</td>
<td>0</td>
<td>Sets the MASH order</td>
</tr>
</tbody>
</table>

**Table 29. Field Descriptions**

<table>
<thead>
<tr>
<th>Location</th>
<th>Field Description</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R34[2:0]</td>
<td>PLL_N</td>
<td>R/W</td>
<td>100</td>
<td>The PLL_N divider value is in the feedback path and divides the VCO frequency.</td>
</tr>
<tr>
<td>R36[15:0]</td>
<td>MASH_SEED_EN</td>
<td>R/W</td>
<td>0</td>
<td>Enabling this bit allows the to be applied to shift the phase at the output or optimize spurs.</td>
</tr>
<tr>
<td>R37[15:8]</td>
<td>PFD_DLY_SEL</td>
<td>R/W</td>
<td>2</td>
<td>The PFD_DLY_SEL must be adjusted in accordance to the N-divider value. This is with the functional description for the N-divider.</td>
</tr>
<tr>
<td>R40[15:0]</td>
<td>PLL_DEN[15:0]</td>
<td>R/W</td>
<td>0</td>
<td>The initial state of the MASH engine first accumulator. Can be used to shift phase or optimize fractional spurs. Every time the field is programmed, it ADDS this MASH seed to the existing one. To reset it, use the MASH_RESET_N bit.</td>
</tr>
<tr>
<td>R42[15:0]</td>
<td>PLL_NUM</td>
<td>R/W</td>
<td>0</td>
<td>The fractional numerator</td>
</tr>
<tr>
<td>R44[13:8]</td>
<td>OUTA_PWR</td>
<td>R/W</td>
<td>31</td>
<td>Adjusts output power. Higher numbers give more output power to a point, depending on the pullup component used.</td>
</tr>
<tr>
<td>R44[7:6]</td>
<td>OUTB_PD</td>
<td>R/W</td>
<td>1</td>
<td>Powers down output B</td>
</tr>
<tr>
<td>R44[5:4]</td>
<td>OUTA_PD</td>
<td>R/W</td>
<td>0</td>
<td>Powers down output A</td>
</tr>
<tr>
<td>R44[3:0]</td>
<td>MASH_RESET_N</td>
<td>R/W</td>
<td>1</td>
<td>Resets MASH circuitry to an initial state</td>
</tr>
<tr>
<td>R44[2:0]</td>
<td>MASH_ORDER</td>
<td>R/W</td>
<td>0</td>
<td>Sets the MASH order</td>
</tr>
</tbody>
</table>
Table 29. Field Descriptions (continued)

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R45[12:11]</td>
<td>OUTA_MUX</td>
<td>R/W</td>
<td>1</td>
<td>Selects what signal goes to RFoutA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Channel divider</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: VCO</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: VCO2X (Also ensure VCO2X_EN=1)</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: High impedance</td>
</tr>
<tr>
<td>R45[10:9]</td>
<td>OUT_ISET</td>
<td>R/W</td>
<td>0</td>
<td>Setting to a lower value allows slightly higher output power at</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>higher frequencies at the expense of higher current consumption.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Maximum output power boost</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>...</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: No output power boost</td>
</tr>
<tr>
<td>R45[5:0]</td>
<td>OUTB_PWR</td>
<td>R/W</td>
<td>31</td>
<td>Output power setting for RFoutB.</td>
</tr>
<tr>
<td>R46[1:0]</td>
<td>OUTB_MUX</td>
<td>R/W</td>
<td>1</td>
<td>Selects what signal goes to RFoutB</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Channel divider</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: VCO</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: SysRef (also ensure SYSREF_EN=1)</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: High impedance</td>
</tr>
</tbody>
</table>

7.6.6 SYNCH and SysRefReq Input Pin Register

Figure 46. Registers Excluding Address

Table 30. Field Descriptions

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R58[15]</td>
<td>INPIN_IGNORE</td>
<td>R/W</td>
<td>1</td>
<td>Ignore SYNC and SysRefReq Pins</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Pins are used. Only valid for VCO_PHASE_SYNC = 1</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Pin is ignored</td>
</tr>
<tr>
<td>R58[14]</td>
<td>INPIN_HYST</td>
<td>R/W</td>
<td>0</td>
<td>High Hysteresis for LVDS mode</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Disabled</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Enabled</td>
</tr>
<tr>
<td>R58[13:12]</td>
<td>INPIN_LVL</td>
<td>R/W</td>
<td>0</td>
<td>Sets bias level for LVDS mode.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>In LVDS mode, a voltage divider can be inserted to reduce susceptibility to</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>common-mode noise of an LVDS line because the input is single-ended.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>With a reasonable setup, TI recommends using INPIN_LVL = 1 (Vin) to use</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>the entire signal swing of an LVDS line.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Vin/4</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Vin</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: Vin/2</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: Invalid</td>
</tr>
<tr>
<td>R58[11:9]</td>
<td>INPIN_FMT</td>
<td>R/W</td>
<td>0</td>
<td>0: SYNC = SysRefReq = CMOS</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: SYNC = LVDS, SysRefReq=CMOS</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: SYCN = CMOS, SysRefReq = LVDS</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: SYCN = SysRefReq = CMOS</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>4: Invalid</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5: Invalid</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>6: Invalid</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>7: Invalid</td>
</tr>
</tbody>
</table>
7.6.7 Lock Detect Registers

Figure 47. Registers Excluding Address

<table>
<thead>
<tr>
<th>D15</th>
<th>D14</th>
<th>D13</th>
<th>D12</th>
<th>D11</th>
<th>D10</th>
<th>D9</th>
<th>D8</th>
<th>D7</th>
<th>D6</th>
<th>D5</th>
<th>D4</th>
<th>D3</th>
<th>D2</th>
<th>D1</th>
<th>D0</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>LD_TYPE</td>
</tr>
<tr>
<td>R60</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>LD_DLY</td>
</tr>
</tbody>
</table>

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 31. Field Descriptions

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R59[0]</td>
<td>LD_TYPE</td>
<td>R/W</td>
<td>1</td>
<td>Lock detect type</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: VCO calibration status</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: VCO calibration status and Indirect Vtune</td>
</tr>
<tr>
<td>R60[15:0]</td>
<td>LD_DLY</td>
<td>R/W</td>
<td>1000</td>
<td>Lock Detect Delay. This is the delay added to the lock detect after the VCO</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>calibration is successful and before the lock detect is asserted high. The</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>delay added is in phase-detector cycles. If set to 0, the lock detect</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>immediately becomes high after the VCO calibration is successful.</td>
</tr>
</tbody>
</table>

7.6.8 MASH_RESET

Figure 48. Registers Excluding Address

<table>
<thead>
<tr>
<th>D15</th>
<th>D14</th>
<th>D13</th>
<th>D12</th>
<th>D11</th>
<th>D10</th>
<th>D9</th>
<th>D8</th>
<th>D7</th>
<th>D6</th>
<th>D5</th>
<th>D4</th>
<th>D3</th>
<th>D2</th>
<th>D1</th>
<th>D0</th>
</tr>
</thead>
<tbody>
<tr>
<td>R69</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>MASH_RST_COUNT[31:16]</td>
</tr>
<tr>
<td>R70</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>MASH_RST_COUNT[15:0]</td>
</tr>
</tbody>
</table>

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 32. Field Descriptions

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R69[15:0]</td>
<td>MASH_RST_COUNT</td>
<td>R/W</td>
<td>50000</td>
<td>If the designer does not use this device in fractional mode with</td>
</tr>
<tr>
<td>R70[15:0]</td>
<td></td>
<td></td>
<td></td>
<td>VCO_PHASE_SYNC = 1, then this field can be set to 0. In phase-sync mode with</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>fractions, this bit is used so that there is a delay for the VCO divider</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>after the MASH is reset. This delay must be set to greater than the lock</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>time of the PLL. It does not impact the latency time of the SYNC feature.</td>
</tr>
</tbody>
</table>
7.6.9 SysREF Registers

![Figure 49. Registers Excluding Address](image)

**Table 33. Field Descriptions**

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R71[7:5]</td>
<td>SYSREF_DIV_PRE</td>
<td>R/W</td>
<td>4</td>
<td>Pre-divider for SYSREF&lt;br&gt;1: Divide by 1&lt;br&gt;2: Divide by 2&lt;br&gt;4: Divide by 4&lt;br&gt;All other states: invalid</td>
</tr>
<tr>
<td>R71[4]</td>
<td>SYSREF_PULSE</td>
<td>R/W</td>
<td>0</td>
<td>Enable pulser mode in master mode&lt;br&gt;0: Disabled&lt;br&gt;1: Enabled</td>
</tr>
<tr>
<td>R71[3]</td>
<td>SYSREF_EN</td>
<td>R/W</td>
<td>0</td>
<td>Enable SYSREF</td>
</tr>
<tr>
<td>R71[2]</td>
<td>SYSREF_REPEAT</td>
<td>R/W</td>
<td>0</td>
<td>Enable repeater mode&lt;br&gt;0: Master mode&lt;br&gt;1: Repeater mode</td>
</tr>
<tr>
<td>R72[10:0]</td>
<td>SYSREF_DIV</td>
<td>R/W</td>
<td>0</td>
<td>Divider for the SYSREF&lt;br&gt;0: Divide by 4&lt;br&gt;1: Divide by 6&lt;br&gt;2: Divide by 8&lt;br&gt;...&lt;br&gt;2047: Divide by 4098</td>
</tr>
<tr>
<td>R73[5:0]</td>
<td>JESD_DAC1_CTRL</td>
<td>R/W</td>
<td>63</td>
<td>These are the adjustments for the delay for the SYSREF. Two of these must be zero and the other two values must sum to 63.</td>
</tr>
<tr>
<td>R73[11:6]</td>
<td>JESD_DAC2_CTRL</td>
<td>R/W</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>R74[5:0]</td>
<td>JESD_DAC3_CTRL</td>
<td>R/W</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>R74[15:12]</td>
<td>SYSREF_PULSE_CNT</td>
<td>R/W</td>
<td>0</td>
<td>Number of pulses in pulse mode in master mode</td>
</tr>
</tbody>
</table>
7.6.10 CHANNEL Divider And VCO Doubler Registers

Figure 50. Registers Excluding Address

<table>
<thead>
<tr>
<th>Reg</th>
<th>15</th>
<th>14</th>
<th>13</th>
<th>12</th>
<th>11</th>
<th>10</th>
<th>9</th>
<th>8</th>
<th>7</th>
<th>6</th>
<th>5</th>
<th>4</th>
<th>3</th>
<th>2</th>
<th>1</th>
<th>0</th>
</tr>
</thead>
<tbody>
<tr>
<td>R25</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
| R27   | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 1  |    | VCO2X
       |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |
| R31   | 0  | CHDIV | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 0  | 1  | 1  | 0  |    |
| R75   | 0  | 0  | 0  | 0  | 0  | 1  | CHDIV | 0  | 0  | 0  | 0  | 0  |    |    |    |    |

Table 34. Field Descriptions

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R25[15:0]</td>
<td>DBLR_IBIAS_CTRL1</td>
<td>R/W</td>
<td>0x0624</td>
<td>VCO doubler current bias control. This value was originally set to 1572 (0x0624). There is no problem with the original value, but setting this to 3115 (0xC2B) can yield better output power, and 1/2 harmonic and noise floor. This register affects only the doubler, and frequency outputs below 15 GHz are not influenced.</td>
</tr>
<tr>
<td>R27[0]</td>
<td>VCO2X_EN</td>
<td>R/W</td>
<td>0</td>
<td>VCO doubler</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Disabled</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Enabled</td>
</tr>
<tr>
<td>R31[14]</td>
<td>SEG1_EN</td>
<td>R/W</td>
<td>0</td>
<td>Enable driver buffer for CHDIV = 2</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Disabled (only valid for CHDIV = 2)</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Enabled (use for CHDIV &gt; 2)</td>
</tr>
<tr>
<td>R75[10:6]</td>
<td>CHDIV</td>
<td>R/W</td>
<td>0</td>
<td>VCO divider value</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: 2</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: 4</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: 6</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: 8</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>4: 12</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5: 16</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>6: 24</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>7: 32</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>8: 48</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>9: 64</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>10: 72</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>11: 96</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>12: 128</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>13: 192</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>14: 256</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>15: 384</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>16: 512</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>17: 768</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>18-31: Reserved</td>
</tr>
</tbody>
</table>
7.6.11 Ramping and Calibration Fields

Figure 51. Registers Excluding Address

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R78[11]</td>
<td>RAMP_THRESH</td>
<td>R/W</td>
<td>0</td>
<td>This sets how much the ramp can change the VCO frequency before calibrating.</td>
</tr>
<tr>
<td>R79[15:0]</td>
<td></td>
<td></td>
<td></td>
<td>If this frequency is chosen to be Δf, then it is calculated as follows:</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>RAMP_THRESH = (Δf / fPD) × 16777216</td>
</tr>
<tr>
<td>R78[9]</td>
<td>QUICK_RECAL_EN</td>
<td>R/W</td>
<td>0</td>
<td>Causes the initial VCO_CORE, VCO_CAPCTRL, and VCO_DACISET to be based on</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>the last value. Useful if the frequency change is small, as is often the</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>case for ramping. 0: Disabled</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Enabled</td>
</tr>
<tr>
<td>R78[8:1]</td>
<td>VCO_CAPCTRL_STRT</td>
<td>R/W</td>
<td>0</td>
<td>This sets the initial value for VCO_CAPCTRL if not overridden by other</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>settings. Smaller values yield a higher frequency band within a VCO core.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>Valid number range is 0 to 183.</td>
</tr>
</tbody>
</table>
7.6.12 Ramping Registers

These registers are only relevant for ramping functions and are enabled if and only if RAMP_EN (R0[15]) = 1.

7.6.12.1 Ramp Limits

Figure 52. Registers Excluding Address

<table>
<thead>
<tr>
<th>Register</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
</table>
| 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 | 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 | 0 | This sets a maximum frequency that the ramp can not exceed so that the VCO does not get set beyond a valid frequency range. Suppose \( f_{\text{HIGH}} \) is this frequency and \( f_{\text{VCO}} \) is the starting VCO frequency then:
For \( f_{\text{HIGH}} \geq f_{\text{VCO}} \):
\[
R\text{AMP\_LIMIT\_HIGH} = \frac{(f_{\text{HIGH}} - f_{\text{VCO}})}{f_{\text{PD}}} \times 16777216
\]
For \( f_{\text{HIGH}} < f_{\text{VCO}} \), this is not a valid condition to choose.
| 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 | 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 | 0 | This sets a minimum frequency that the ramp can not exceed so that the VCO does not get set beyond a valid frequency range. Suppose \( f_{\text{LOW}} \) is this frequency and \( f_{\text{VCO}} \) is the starting VCO frequency then:
For \( f_{\text{LOW}} \leq f_{\text{VCO}} \):
\[
R\text{AMP\_LIMIT\_LOW} = 2^{33} - 16777216 \times \frac{(f_{\text{VCO}} - f_{\text{LOW}})}{f_{\text{PD}}}
\]
For \( f_{\text{LOW}} > f_{\text{VCO}} \), this is not a valid condition to choose.

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 36. Field Descriptions
7.6.12.2 Ramping Triggers, Burst Mode, and RAMP0_RST

Figure 53. Registers Excluding Address

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R96[15]</td>
<td>RAMP_BURST_EN</td>
<td>R/W</td>
<td>0</td>
<td>Enables burst ramping mode. In this mode, a RAMP_BURST_COUNT ramps are sent out when RAMP_EN is set from 0 to 1. 0: Disabled 1: Enabled</td>
</tr>
<tr>
<td>R97[1:0]</td>
<td>RAMP_BURST_TRIG</td>
<td>R/W</td>
<td>0</td>
<td>Ramp burst trigger definition that triggers the next ramp in the count. Note that RAMP_EN starts the count, not this word. 0: Ramp Transition 1: Trigger A 2: Trigger B 3: Reserved</td>
</tr>
<tr>
<td>R97[6:3]</td>
<td>RAMP_TRIGA</td>
<td>R/W</td>
<td>0</td>
<td>Multipurpose Trigger A definition: 0: Disabled 1: RampClk pin rising edge 2: RampDir pin rising edge 4: Always triggered 9: RampClk pin falling edge 10: RampDir pin falling edge All other states: reserved</td>
</tr>
<tr>
<td>R97[10:7]</td>
<td>RAMP_TRIGB</td>
<td>R/W</td>
<td>0</td>
<td>Multipurpose trigger B definition: 0: Disabled 1: RampClk pin Rising Edge 2: RampDir pin Rising Edge 4: Always Triggered 9: RampClk pin Falling Edge 10: RampDir pin Falling Edge All other states: Reserved</td>
</tr>
<tr>
<td>R97[15]</td>
<td>RAMP0_RST</td>
<td>R/W</td>
<td>0</td>
<td>Resets RAMP0 at start of ramp to eliminate round-off errors. Must only be used in automatic ramping mode. 0: Disabled 1: Enabled</td>
</tr>
</tbody>
</table>

RAMP0_RST = 0 resets RAMP0 at start of ramp to eliminate round-off errors. Must only be used in automatic ramping mode. 0: Disabled 1: Enabled

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset
7.6.12.3 Ramping Configuration

**Figure 54. Registers Excluding Address**

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R98[15:2]</td>
<td>RAMP0 INC</td>
<td>R/W</td>
<td>0</td>
<td>2's complement of the amount the RAMP0 is incremented in phase detector cycles.</td>
</tr>
<tr>
<td>R99[0]</td>
<td>RAMP0 DLY</td>
<td>R/W</td>
<td>0</td>
<td>Enabling this bit uses two clocks instead of one to clock the ramp. Effectively doubling the length. 0: Normal ramp length 1: Double ramp length</td>
</tr>
<tr>
<td>R100[15:0]</td>
<td>RAMP0 LEN</td>
<td>R/W</td>
<td>0</td>
<td>Length of RAMP0 in phase detector cycles</td>
</tr>
<tr>
<td>R101[6]</td>
<td>RAMP1 DLY</td>
<td>R/W</td>
<td>0</td>
<td>Enabling this bit uses two clocks instead of one to clock the ramp. Effectively doubling the length. 0: Normal ramp length 1: Double ramp length</td>
</tr>
<tr>
<td>R101[5]</td>
<td>RAMP1 RST</td>
<td>R/W</td>
<td>0</td>
<td>Resets RAMP1 to eliminate rounding errors. Must be used in automatic ramping mode. 0: Disabled 1: Enabled</td>
</tr>
<tr>
<td>R101[4]</td>
<td>RAMP0 NEXT</td>
<td>R/W</td>
<td>0</td>
<td>Defines what ramp comes after RAMP0 0: RAMP0 1: RAMP1</td>
</tr>
<tr>
<td>R101[1:0]</td>
<td>RAMP0 NEXT TRIG</td>
<td>R/W</td>
<td>0</td>
<td>Defines what triggers the next ramp 0: RAMP0 LEN timeout counter 1: Trigger A 2: Trigger B 3: Reserved</td>
</tr>
<tr>
<td>R102[13:0]</td>
<td>R103[15:0]</td>
<td>R/W</td>
<td>0</td>
<td>2's complement of the amount the RAMP1 is incremented in phase detector cycles.</td>
</tr>
<tr>
<td>R104[15:0]</td>
<td>RAMP1 LEN</td>
<td>R/W</td>
<td>0</td>
<td>Length of RAMP1 in phase detector cycles</td>
</tr>
<tr>
<td>R105[15:6]</td>
<td>RAMP DLY CNT</td>
<td>R/W</td>
<td>0</td>
<td>This is the number of state machine clock cycles for the VCO calibration in automatic mode. If the VCO calibration is less, then it is this time. If it is more, then the time is the VCO calibration time.</td>
</tr>
<tr>
<td>R105[5]</td>
<td>RAMP MANUAL</td>
<td>R/W</td>
<td>0</td>
<td>Enables manual ramping mode, or otherwise automatic mode 0: Automatic ramping mode 1: Manual ramping mode</td>
</tr>
</tbody>
</table>
Table 38. Field Descriptions (continued)

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R105[4]</td>
<td>RAMP1_NEXT</td>
<td>R/W</td>
<td>0</td>
<td>Determines what ramp comes after RAMP1:</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: RAMP0</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: RAMP1</td>
</tr>
<tr>
<td>R105[1:0]</td>
<td>RAMP1_NEXT_TRIG</td>
<td>R/W</td>
<td>0</td>
<td>Defines what triggers the next ramp</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: RAMP1_LEN timeout counter</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Trigger A</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: Trigger B</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: Reserved</td>
</tr>
<tr>
<td>R106[4]</td>
<td>RAMP_TRIG_CAL</td>
<td>R/W</td>
<td>0</td>
<td>Enabling this bit forces the VCO to calibrate after</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>the ramp.</td>
</tr>
<tr>
<td>R106[2:0]</td>
<td>RAMP_SCALE_COUNT</td>
<td>R/W</td>
<td>7</td>
<td>Multiplies RAMP_DLY count by (2^{\text{RAMP SCALE COUNT}})</td>
</tr>
</tbody>
</table>

7.6.13 Readback Registers

Figure 55. Registers Excluding Address

<table>
<thead>
<tr>
<th></th>
<th>D15</th>
<th>D14</th>
<th>D13</th>
<th>D12</th>
<th>D11</th>
<th>D10</th>
<th>D9</th>
<th>D8</th>
<th>D7</th>
<th>D6</th>
<th>D5</th>
<th>D4</th>
<th>D3</th>
<th>D2</th>
<th>D1</th>
<th>D0</th>
</tr>
</thead>
<tbody>
<tr>
<td>R110</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>rb_LD_VTUNE</td>
<td>0</td>
<td>rb_VCO_SEL</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td></td>
<td></td>
</tr>
<tr>
<td>R111</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>R112</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>rb_VCO_CAPCTRL</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 39. Field Descriptions

<table>
<thead>
<tr>
<th>Location</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>R110[10:9]</td>
<td>rb_LD_VTUNE</td>
<td>R</td>
<td>0</td>
<td>Readback of Vtune lock detect</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Unlocked (Vtune low)</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: Invalid State</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>2: Locked</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3: Unlocked (Vtune High)</td>
</tr>
<tr>
<td>R110[7:5]</td>
<td>rb_VCO_SEL</td>
<td>R</td>
<td>0</td>
<td>Reads back the actual VCO that the calibration has</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>selected.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0: Invalid</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1: VCO1</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>7: VCO7</td>
</tr>
<tr>
<td>R111[7:0]</td>
<td>rb_VCO_CAPCTRL</td>
<td>R</td>
<td>183</td>
<td>Reads back the actual CAPCTRL capcode value the VCO</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>calibration has chosen.</td>
</tr>
<tr>
<td>R112[8:0]</td>
<td>rb_VCO_DACISET</td>
<td>R</td>
<td>170</td>
<td>Reads back the actual amplitude (DACISET) value that</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>the VCO calibration has chosen.</td>
</tr>
</tbody>
</table>
8 Application and Implementation

NOTE
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

8.1.1 OSCin Configuration
The OSCin supports single-ended or differential clocks. There must be a AC-coupling capacitor in series before the device pin. The OSCin inputs are high-impedance CMOS with internal bias voltage. TI recommends putting termination shunt resistors to terminate the differential traces (if there are 50-Ω characteristic traces, place 50-Ω resistors). The OSCin and OSCin* side should be matched in layout. A series AC-coupling capacitors should immediately follow OSCin pins in the board layout, then the shunt termination resistors to ground should be placed after.

Input clock definitions are shown in Figure 56:

8.1.2 OSCin Slew Rate
The slew rate of the OSCin signal can impact the spurs and phase noise of the LMX2595 if it is too low. In general, a high slew rate and a lower amplitude signal, such as LVDS, can give best performance.

8.1.3 RF Output Buffer Power Control
The OUTA_PWR and OUTB_PWR registers can be used to control the output power of the output buffers. The setting for optimal power may depend on the pullup component, but is typically around 50. The higher the setting, the higher the current consumption of the output buffer.

8.1.4 RF Output Buffer Pullup
The choice of output buffer components is very important and can have a profound impact on the output power. Table 40 shows how to treat each pin. If using a single-ended output, a pullup is required, and the user can put a 50-Ω resistor after the capacitor.
Application Information (continued)

Table 40. Different Methods for Pullup on Outputs

<table>
<thead>
<tr>
<th>PULLUP STYLE</th>
<th>DIAGRAM</th>
<th>COMMENTS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Inductor</td>
<td>![Inductor Diagram]</td>
<td>Potentially higher output power, but output impedance is far from 50 Ω. Consider also using with a resistive pad.</td>
</tr>
<tr>
<td>Resistor</td>
<td>![Resistor Diagram]</td>
<td>More consistent matching</td>
</tr>
</tbody>
</table>

Table 41. Output Pullup Configuration

<table>
<thead>
<tr>
<th>COMPONENT</th>
<th>VALUE</th>
<th>PART NUMBER</th>
</tr>
</thead>
<tbody>
<tr>
<td>Inductor</td>
<td>Varies with frequency</td>
<td>Vishay FC0402E50R0BST1</td>
</tr>
<tr>
<td>Resistor</td>
<td>50 Ω</td>
<td>ATC 520L103KT16T</td>
</tr>
<tr>
<td>Capacitor</td>
<td>Varies with frequency</td>
<td>ATC 504L50R0FTNCFT</td>
</tr>
</tbody>
</table>

8.1.5 Performance Comparison Between 1572 (0x0624) and 3115 (0x0C2B) for Register DBLR_IBIAS_CTRL1 (R25[15:0])

There is a new setting for register DBLR_IBIAS_CTRL1 (R25[15:0]): from 1572 (0x0624) to 3115 (0x0C2B). The old setting can operate up to 19-GHz output, but the new setting can extend the frequency range to 20 GHz. The field name DBLR_IBIAS_CTRL1 is short for "Doubler Current Bias Control 1". It only impacts the doubler and does not affect the performance below 15 GHz. Shown in Figure 57 and Figure 58, with old R25 value, the output power and phase noise floor fall apart beyond 19 GHz. But with the new setting, they remain stable up to 20 GHz. Figure 59 and Figure 60 show that new R25 value leads to less output power variation with temperature at high frequencies. Figure 61 shows the improvement in half harmonic.
Figure 57. Phase Noise Floor Across Frequency: 
DBLR_IBIAS_CTRL1 (R25[15:0]) Value Old vs New

Figure 58. Output Power Across Frequency: 
DBLR_IBIAS_CTRL1 (R25[15:0]) Value Old vs New

Figure 59. Output Power Variation Versus Temperature: 
DBLR_IBIAS_CTRL1 = 1572

Figure 60. Output Power Variation Versus Temperature: 
DBLR_IBIAS_CTRL1 = 3115

Figure 61. 1/2 Harmonic Across Frequency: DBLR_IBIAS_CTRL1 (R25[15:0]) Value Old vs New
8.2 Typical Application

Figure 62. Typical Application Schematic
8.2.1 Design Requirements

The design of the loop filter is complex and is typically done with software. The PLLATINUM™ Sim software is an excellent resource for doing this and the design is shown in the Figure 63. For those interested in the equations involved, the PLL Performance, Simulation, and Design Handbook listed in the end of this document goes into great detail as to the theory and design of PLL loop filters.

![Figure 63. PLLATINUM™ Sim Design Screen](image)

8.2.2 Detailed Design Procedure

The integration of phase noise over a certain bandwidth (jitter) is an performance specification that translates to signal-to-noise ratio. Phase noise inside the loop bandwidth is dominated by the PLL, while the phase noise outside the loop bandwidth is dominated by the VCO. Generally, jitter is lowest if the loop bandwidth is designed to the point where the two intersect. A higher phase margin loop filter design has less peaking at the loop bandwidth and thus lower jitter. The tradeoff with this is that longer lock times and spurs must be considered in design as well.
8.2.3 Application Curve

![Figure 64. Typical Jitter](image-url)

- **Figure 64. Typical Jitter**
9 Power Supply Recommendations

If fractional spurs are a large concern, using a ferrite bead to each of these power supply pins can reduce spurs to a small degree. This device has integrated LDOs, which improves the resistance to power supply noise. However, the pullup components on the RFoutA and RFoutB pins on the outputs have a direct connection to the power supply, take extra care to ensure that the voltage is clean for these pins. Figure 65 is a typical application example.

This device can be powered by an external DC-DC buck converter, such as the TPS62150. Note that although Rtps, Rtps1, and Rtps2 are 0 Ω in the schematic, they could be potentially replaced with a larger resistor value or inductor value for better power supply filtering.

For DC bias levels, refer to Table 42.

Table 42. Bias Levels of Pins

<table>
<thead>
<tr>
<th>Pin Number</th>
<th>Pin Name</th>
<th>Bias Level (1)</th>
</tr>
</thead>
<tbody>
<tr>
<td>3</td>
<td>VBIASVCO</td>
<td>1.3</td>
</tr>
<tr>
<td>27</td>
<td>VBIASVCO2</td>
<td>0.7</td>
</tr>
<tr>
<td>29</td>
<td>VREFVCO2</td>
<td>2.9</td>
</tr>
<tr>
<td>33</td>
<td>VBIASVARAC</td>
<td>1.7</td>
</tr>
<tr>
<td>36</td>
<td>VREFVCO</td>
<td>2.9</td>
</tr>
<tr>
<td>38</td>
<td>VREGVCO</td>
<td>2.1</td>
</tr>
</tbody>
</table>

(1) The bias level is measured after following Recommended Initial Power-Up Sequence.

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10 Layout

10.1 Layout Guidelines

In general, the layout guidelines are similar to most other PLL devices. Here are some specific guidelines.

- GND pins may be routed on the package back to the DAP.
- The OSCin pins are internally biased and must be AC-coupled.
- If not used, RampClk, RampDir, and SysRefReq can be grounded to the DAP.
- For the Vtune pin, try to place a loop filter capacitor as close as possible to the pin. This may mean separating the capacitor from the rest of the loop filter.
- For the outputs, keep the pullup component as close as possible to the pin and use the same component on each side of the differential pair.
- If a single-ended output is needed, the other side must have the same loading and pullup. However, the routing for the used side can be optimized by routing the complementary side through a via to the other side of the board. On this side, use the same pullup and make the load look equivalent to the side that is used.
- Ensure that DAP on device is well-grounded with many vias, preferably copper filled.
- Have a thermal pad that is as large as the LMX2595 exposed pad. Add vias to the thermal pad to maximize thermal performance.
- Use a low loss dielectric material, such as Rogers 4003, for optimal output power.
- See instructions for the LMX2595EVM (LMX2594 EVM Instructions, 15 GHz Wideband Low Noise PLL With Integrated VCO) for more details on layout.
10.2 Layout Example

Figure 66. LMX2594 PCB Layout
11 Device and Documentation Support

11.1 Device Support

11.1.1 Third-Party Products Disclaimer
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11.1.2 Development Support
Texas Instruments has several software tools to aid in the development at www.ti.com. Among these tools are:
• EVM software to understand how to program the device and for programming the EVM board.
• EVM board instructions for seeing typical measured data with detailed measurement conditions and a complete design.
• PLLatinum Sim program for designing loop filters, simulating phase noise, and simulating spurs.

11.2 Documentation Support

11.2.1 Related Documentation
For related documentation see the following:
• AN-1879 Fractional N Frequency Synthesis (SNA062)
• PLL Performance, Simulation, and Design Handbook (SNA106)
• LMX2594 EVM Instructions –15-GHz Wideband Low Noise PLL With Integrated VCO (SNAU210)

11.3 Receiving Notification of Documentation Updates
To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.4 Community Resources
The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.5 Trademarks
PLLATINUM, E2E are trademarks of Texas Instruments. All other trademarks are the property of their respective owners.

11.6 Electrostatic Discharge Caution
These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.7 Glossary
SLYZ022 — TI Glossary.
This glossary lists and explains terms, acronyms, and definitions.
12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.
## PACKAGING INFORMATION

<table>
<thead>
<tr>
<th>Orderable Device</th>
<th>Status (1)</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>Package Qty</th>
<th>Eco Plan (2)</th>
<th>Lead/Ball Finish (6)</th>
<th>MSL Peak Temp (3)</th>
<th>Op Temp (°C)</th>
<th>Device Marking (4/5)</th>
<th>Samples</th>
</tr>
</thead>
<tbody>
<tr>
<td>LMX2595RHAR</td>
<td>ACTIVE</td>
<td>VQFN</td>
<td>RHA</td>
<td>40</td>
<td>2500</td>
<td>Green (RoHS &amp; no Sb/Br)</td>
<td>NIPDAUAG</td>
<td>Level-3-260C-168 HR</td>
<td>-40 to 85</td>
<td>LMX2595</td>
<td>Samples</td>
</tr>
<tr>
<td>LMX2595RHAT</td>
<td>ACTIVE</td>
<td>VQFN</td>
<td>RHA</td>
<td>40</td>
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<td>Level-3-260C-168 HR</td>
<td>-40 to 85</td>
<td>LMX2595</td>
<td>Samples</td>
</tr>
</tbody>
</table>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.
**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.
**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

*All dimensions are nominal*

<table>
<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Reel Diameter (mm)</th>
<th>Reel Width W1 (mm)</th>
<th>A0 (mm)</th>
<th>B0 (mm)</th>
<th>K0 (mm)</th>
<th>P1 (mm)</th>
<th>W (mm)</th>
<th>Pin 1 Quadrant</th>
</tr>
</thead>
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<td>RHA</td>
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<td>12.0</td>
<td>16.0</td>
<td>Q1</td>
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<tr>
<td>LMX2595RHAT</td>
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<td>RHA</td>
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<td>250</td>
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<td>6.3</td>
<td>6.3</td>
<td>1.5</td>
<td>12.0</td>
<td>16.0</td>
<td>Q1</td>
</tr>
</tbody>
</table>

**TAPE DIMENSIONS**

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P1: Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

*Images of reel dimensions, tape dimensions, and quadrant assignments are provided.*
**Tape and Reel Box Dimensions**

*All dimensions are nominal*

<table>
<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Length (mm)</th>
<th>Width (mm)</th>
<th>Height (mm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>LMX2595RHAR</td>
<td>VQFN</td>
<td>RHA</td>
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<td>2500</td>
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<td>38.0</td>
</tr>
<tr>
<td>LMX2595RHAT</td>
<td>VQFN</td>
<td>RHA</td>
<td>40</td>
<td>250</td>
<td>210.0</td>
<td>185.0</td>
<td>35.0</td>
</tr>
</tbody>
</table>
NOTES:
A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M–1994.
B. This drawing is subject to change without notice.
C. QFN (Quad Flatpack No-Lead) Package configuration.
D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
F. Package complies to JEDEC MO-220 variation VJUD-2.
THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.

```
PIN 1 INDICATOR
C0,30

4,50±0,10

31
30
20
10
11

Exposed Thermal Pad

Bottom View

Exposed Thermal Pad Dimensions
```

NOTES:
A. All linear dimensions are in millimeters

www.ti.com
NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com (http://www.ti.com).
E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
F. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for vias placed in the thermal pad.
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